

# Power-Line Communications Analog Front-End

Check for Samples: AFE032

# FEATURES

- Supports:
  - CENELEC Bands A, B, C, D
  - ARIB STD-T84, FCC
  - FSK, SFSK, and NB-OFDM
- Conforms To:
  - EN50065-1, -2, -3, -7
  - FCC, Part 15
  - ARIB STD-T84
- Standards:
  - G3, PRIME, P1901.2, ITU-G.hnem
- Programmable Tx Low-Pass Filters and Rx Band-Pass Filters
- Integrated Power-Line Driver with Thermal and Overcurrent Protection
- Low-Power Consumption:
  - 50 mW (Receiver Mode)
- Receive Sensitivity: 10 μV<sub>RMS</sub> (Typ)
- Four-Wire SPI<sup>™</sup> Interface
- Three Integrated Zero-Crossing Detectors
- Package: QFN-48 PowerPAD<sup>™</sup>
- Extended Temperature Range: -40°C to +125°C

# **APPLICATIONS**

- eMetering
- Home Area Networks
- Lighting
- Solar
- Pilot Wires and EVSEs

## DESCRIPTION

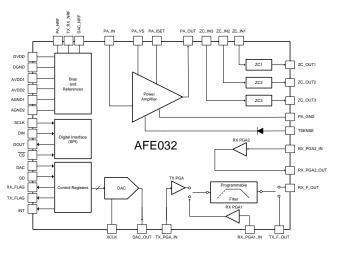
The AFE032 is a low-cost, integrated, power-line communications (PLC), analog front-end (AFE) device capable of transformer-coupled connections to the power-line while under the control of a digital signal processor (DSP) or microcontroller. This device is ideal for driving high-current, low-impedance lines up to 1.9 A into reactive loads.

The integrated receiver is able to detect signals down to 10  $\mu$ V<sub>RMS</sub> (G3-FCC mode) and is capable of a wide range of gain options to adapt to varying input-signal conditions. The monolithic integrated circuit provides high reliability in demanding power-line communication applications.

The AFE032 transmit power amplifier operates from a single supply in the range of 7 V to 24 V. At typical load current ( $I_{OUT} = 1.5 A_{PEAK}$ ), a wide output swing provides a 12-V<sub>PP</sub> capability with a nominal 15-V supply.

The device is internally protected against overtemperature and short-circuit conditions. The device also provides a selectable current limit. An interrupt output is provided, indicating current limit, thermal limit, and undervoltage. A shutdown pin is also available, and can be used to quickly place the device into the lowest-power state. Each functional block can be enabled or disabled to optimize power dissipation through the serial peripheral interface (SPI),

The AFE032 is housed in a thermally-enhanced, surface-mount, PowerPAD, QFN-48 package. Operation is specified over the extended industrial junction temperature range of  $-40^{\circ}$ C to  $+125^{\circ}$ C.



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## ORDERING INFORMATION<sup>(1)</sup>

(1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or visit the device product folder at www.ti.com.

# ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Over operating free-air temperature range, unless otherwise noted.

				VALUE	UNIT
PA_VS	Supply voltage (pins 44, 4	5)		+26	V
			Pins 3, 4, 6, 7, 8, 10	DGND - 0.4 to DVDD + 0.4	V
		V II. (2)	Pins 13, 21, 28, 31, 32, 38, 39	AGND - 0.4 to AVDD + 0.4	V
		Voltage <sup>(2)</sup>	Pins 18, 19	PA_GND - 0.4 to PA_VS + 0.4	V
			Pin 27	AVDD + 0.4 to 26	V
	Signal input terminals		Pins 3, 4, 6, 7, 8, 10	±10	mA
		Current <sup>(2)</sup>	Pins 13, 21, 28, 31, 32, 38, 39	±10	mA
		Current	Pins 18, 19	±10	mA
			Pin 35	±10	mA
			Pins 5, 9, 47, 48	DGND - 0.4 to DVDD + 0.4	V
		Voltage	Pins 14, 17, 20, 22, 33, 36, 37	AGND - 0.4 to AVDD + 0.4	V
			Pins 42, 43	PA_GND - 0.4 to PA_VS + 0.4	V
	Signal output terminals	Current; short-circuit to GND	Pins 5, 9, 47, 48	Continuous	
		Current; short-circuit to GND	Pins 14, 17, 20, 22, 33, 36, 37	Continuous	
		Current; short-circuit to GND	Pins 42, 43	Continuous	
AVDD	Analog supply voltage (pir	ns 11, 30)		5.5	V
DVDD	Digital supply voltage			5.5	V
T <sub>A</sub>	Operating temperature <sup>(3)</sup>			-40 to +150	°C
T <sub>stg</sub>	Storage temperature			-55 to +150	°C
TJ	Junction temperature			+150	°C
		Human body model (HBM)		3000	V
ESD	Electrostatic discharge ratings	Machine model (MM)		200	V
		Charged device model (CDM)		500	V

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and do not imply functional operation of the device at these or any other conditions beyond those indicated. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.4 V beyond the supply rails should be current limited to 10 mA or less.

(3) The device automatically goes to shutdown above +165°C.

## THERMAL INFORMATION

		AFE032	
	THERMAL METRIC <sup>(1)</sup>	RGZ (QFN)	UNITS
		48 PINS	
θ <sub>JA</sub>	Junction-to-ambient thermal resistance	22.5	
θ <sub>JCtop</sub>	Junction-to-case (top) thermal resistance	12.1	
θ <sub>JB</sub>	Junction-to-board thermal resistance	7.5	°C/W
Ψյт	Junction-to-top characterization parameter	2.0	-C/W
Ψјв	Junction-to-board characterization parameter	5.4	
θ <sub>JCbot</sub>	Junction-to-case (bottom) thermal resistance	1.7	

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.



**AFE032** 

## **ELECTRICAL CHARACTERISTICS: Transmitter**

At  $T_{CASE} = +25^{\circ}C$ ,  $V_{PAVS} = 15$  V, and  $V_{AVDD} = V_{DVDD} = 3.3$  V, unless otherwise noted.

	PARAMET	ER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
DAC							
	Resolution		12-bit DAC, internal $V_{REF} = 0.7 V$	165	171	176	μV
DR	Data rate <sup>(1)</sup>		DAC pin high, 12-bit word		4.8	5.2	MSPS
G <sub>E</sub>	Gain error		Full-scale range, $T_J = -40^{\circ}C$ to +125°C	-2%	±0.5%	2%	
DAC OU	ITPUT						
Ro	Output resistance		G = 1, f = 100 kHz		1		kΩ
TX_PGA	INPUT						
	Input voltage rang	je		(AGND + 0.15) / gain	(AVDD	– 0.15) / gain	V
			G = 1.15 V/V		52		kΩ
<b>D</b>	land and internet		G = 2.3 V/V		34		kΩ
RI	Input resistance		G = 3.25 V/V		26		kΩ
			G = 4.6 V/V		20		kΩ
G	Gain			1.15, 2	20 .3, 3.25, 4.6 <sup>(2)</sup>		V/V
G <sub>E</sub>	Gain error		Includes DAC, programmable filter, and TX_PGA for all gains, $T_J = -40^{\circ}$ C to +125°C	-2%	±0.1%	2%	
	Gain error drift		Includes DAC, programmable filter, and TX_PGA for all gains, $T_J = -40^{\circ}C$ to +125°C	-10	±3	+10	ppm/°C
TX_PGA	FREQUENCY RESP	ONSE					
			$C_L = 20 \text{ pF}, \text{ G} = 1.15 \text{ V/V},$ $T_J = -40^{\circ}\text{C} \text{ to } +125^{\circ}\text{C}$		30		MHz
BW	Bandwidth <sup>(3)</sup>		$C_L = 20 \text{ pF}, \text{ G} = 2.3 \text{ V/V}, T_J = -40^{\circ}\text{C} \text{ to } +125^{\circ}\text{C}$		21.5		MHz
DVV	Banawidin		$C_L = 20 \text{ pF}, \text{ G} = 3.25 \text{ V/V}, T_J = -40^{\circ}\text{C} \text{ to } +125^{\circ}\text{C}$		17.5	MHz MHz MHz MHz MHz	
			$C_L = 20 \text{ pF}, \text{ G} = 4.6 \text{ V/V}, T_J = -40^{\circ}\text{C} \text{ to } +125^{\circ}\text{C}$		15.5		MHz
TX PATH	H TRANSMITTER NO	ISE <sup>(4)</sup>					
		CEN-A	35 kHz to 95 kHz		370		$\mu V_{\text{RMS}}$
		CEN-B	95 kHz to 125 kHz		220		$\mu V_{\text{RMS}}$
		CEN-C	125 kHz to 140 kHz		160		$\mu V_{\text{RMS}}$
	Integrated noise at PA output <sup>(5)</sup>	CEN-D	140 kHz to 148 kHz		98		$\mu V_{RMS}$
		ARIB STD-T84	35 kHz to 420 kHz		640		$\mu V_{RMS}$
		FCC-LOW	35 kHz to 125 kHz		384		$\mu V_{\text{RMS}}$
		G3-FCC	150 kHz to 490 kHz		565		$\mu V_{\text{RMS}}$
POWER	AMPLIFIER (PA) INF	TUT					
	Input voltage rang	je	For linear operation	(PA_GND + 0.4) / gain	(PA_V	S – 0.4) / gain	V
	Input impedance			-	17		kΩ
PA FREG	QUENCY RESPONSE	E		I		1	
BW	Bandwidth		I <sub>LOAD</sub> = 0 mA	3.4	3.82	4.23	MHz
SR	Slew rate		PA_VS = 24 V, 20-V step		75		V/µs
	Full-power bandw	idth	$PA_VS = 24 \text{ V}, \text{ V}_{OUT} = 20 \text{ V}_{PP}$		1		MHz
PSRR	Power-supply reje		RTI, dc to $f = 50$ kHz	80	94		dB

(1) Refer to the Application Information section.

(2) This parameter is from DAC\_OUT to TX\_F\_OUT. This parameter includes the LPF gain error and is the dc gain. Adding LPF causes some loss of gain flatness.

This parameter is internal to the device. Bandwidth is designed and simulated over corners to ensure a low-distortion PGA in the (3) application.

Includes the DAC, programmable filter, TX\_PGA, and PA noise-reducing capacitor = 1 nF from DAC\_NRF to ground, PA\_NRF to (4) ground, and TX\_RF\_NRF to ground.

Includes the DAC, TX\_PGA (gain = 4.6), LPF, and PA. (5)

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# **ELECTRICAL CHARACTERISTICS: Transmitter (continued)**

At  $T_{CASE}$  = +25°C,  $V_{PAVS}$  = 15 V, and  $V_{AVDD}$  =  $V_{DVDD}$  = 3.3 V, unless otherwise noted.

	PARAME	TER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
PA OU	TPUT						
			I <sub>O</sub> = 200-mA sourcing, 1-ms pulse			0.5	V
	Voltage output	From PA_VS	I <sub>O</sub> = 1.5-A sourcing, 1-ms pulse			2.25	V
Vo	swing	From PA GND	$I_0 = 200 \text{ mA sinking}, 1\text{-ms pulse}$			0.5	V
		FIOIII FA_GIND	$I_0 = 1.5$ -A sinking, 1-ms pulse			1.5	V
	Maximum continuous current, dc		Pin 26 connected to ground, REG_PA_CURRENT_CFG[5:4] = 11		1.9		А
	Output resistance	e	I <sub>O</sub> = 1.9 A, f = 500 kHz		0.1		Ω
	PA disabled outp	ut impedance	f = 100 kHz, PA_NRF enabled		130    105		kΩ    pF
	Resistor-selectable		R <sub>SET</sub> connected from pin 26 to ground	See the	Application In	formation :	section
	Output current limit		Pin 26 connected to ground, REG_PA_CURRENT_CFG[5:4] = 00		1.25		А
			Pin 26 connected to ground, REG_PA_CURRENT_CFG[5:4] = 01		1.8		А
		Digitally-selectable <sup>(6)</sup>	Pin 26 connected to ground, REG_PA_CURRENT_CFG[5:4] = 10		2.5		kΩ    pF section A A A A A
			Pin 26 connected to ground, REG_PA_CURRENT_CFG[5:4] = 11		3.0		А
PA TH	ERMAL SHUTDOWN						
	Junction tempera	ature at shutdown			+165		°C
	Hysteresis				+15		°C
	Return to normal	operation			+150		°C
PA TSE	ENSE DIODE						
η	Diode ideality fac	tor			1.03		
PA GA	IN						
G	Nominal gain		PA_OUT / PA_IN		7.4 <sup>(7)</sup>		V/V
G <sub>E</sub>	Gain error		$T_{J} = -40^{\circ}C \text{ to } +125^{\circ}C$	-2%	0.1%	2%	
	Gain error drift		$T_{J} = -40^{\circ}C \text{ to } +125^{\circ}C$		±5		ppm/°C

(6)

Refer to the *Application Information* section. This gain reflects a direct measurement on the PA block by itself. The gain in the signal chain composed by Tx PGA, Tx Filter and PA (7) equals the Tx PGA gain multiplied by 7 V/V (where 7 V/V is the gain of the PA block when its input is capacitively coupled to the Tx Filter output). Refer to the Power Amplifier Block section for more information.



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## ELECTRICAL CHARACTERISTICS: Programmable Filter

At  $T_{CASE}$  = +25°C,  $V_{PAVS}$  = 15 V, and  $V_{AVDD}$  =  $V_{DVDD}$  = 3.3 V, unless otherwise noted.

	PARAME	TER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
LOW-PASS	FILTER (LPF)		I				
0.1.11	CEN-A		1-dB gain flatness, $T_J = -40^{\circ}C$ to +125°C	94	102	110	kHz
Cutoff frequencies in Tx mode <sup>(1)</sup>	CEN-B, CEN-C, CE	N-D, FCC-LOW	1-dB gain flatness, $T_J = -40^{\circ}C$ to +125°C	148	160	172	kHz
	ARIB STD-T84		1-dB gain flatness, $T_J = -40^{\circ}C$ to +125°C	405	435	475	kHz
mode	G3-FCC		1-dB gain flatness, $T_J = -40^{\circ}C$ to +125°C	470	505	540	kHz
	Transition time		PA_NRF, TX_RX_NRF, and DAC, T <sub>J</sub> = $-40^{\circ}$ C to $+125^{\circ}$ C		80 <sup>(2)</sup>		μs
	Tx to Rx		NRF enabled, $T_J = -40^{\circ}C$ to +125°C		30		μs
LPF OUTPU	т						
R <sub>0</sub>	Output impedance		f = 100 kHz		1		kΩ
HIGH-PASS	FILTER (HPF)						
	CEN-A, CEN-B, CE ARIB STD-T84, FC		1-dB gain flatness, T <sub>J</sub> = -40°C to +125°C	30	35	40	kHz
	G3-FCC		1-dB gain flatness, $T_J = -40^{\circ}C$ to +125°C	120	132	152	kHz
	Transition time		PA_NRF, TX_RX_NRF, and DAC, T <sub>J</sub> = $-40^{\circ}$ C to $+125^{\circ}$ C		30		μs
		Tx to Rx	NRF enabled, $T_J = -40^{\circ}C$ to $+125^{\circ}C$		80 <sup>(2)</sup>		μs
HPF OUTPU	т	·	· · ·	•		•	
R <sub>0</sub>	Output impedance		f = 100 kHz		1		kΩ

(1) These cutoff frequencies are only valid when the filter is used as a low-pass filter. Refer to the *Register Map* section in the *Application Information* for register settings.

(2) See the Application Information section for the start-up procedure.

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# ELECTRICAL CHARACTERISTICS: Receiver

At  $T_{CASE}$  = +25°C,  $V_{PAVS}$  = 15 V, and  $V_{AVDD}$  =  $V_{DVDD}$  = 3.3 V, unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN TYP MAX	UNIT
RX_PG	A1 INPUT			
	Input voltage range	For linear operation	(AGND + 0.15) / (AVDD - 0.15) / gain gain	V
		G = 0.125 V/V	111.1	kΩ
		G = 0.25 V/V	100	kΩ
		G = 0.5 V/V	133	kΩ
		G = 1 V/V	100	kΩ
RI	Input resistance	G = 2 V/V	66	kΩ
		G = 4 V/V	40	kΩ
		G = 8 V/V	22	kΩ
		G = 16 V/V	12	kΩ
		G = 32 V/V	6	kΩ
RX_PG	A1 GAIN		-	-j
	DC gain		0.125, 0.25, 0.5, 1, 2, 4, 8, 16, 32	V/V
G <sub>E</sub>	Gain error	For all gains, $T_J = -40^{\circ}C$ to +125°C	-5% 5%	
	Gain error drift	$T_{\rm J} = -40^{\circ}{\rm C}$ to +125°C	±100	ppm/°C
RX_PG	A1 FREQUENCY RESPONSE			
		C <sub>L</sub> = 20 pF, G = 0.125 V/V	47	MHz
		C <sub>L</sub> = 20 pF, G = 0.25 V/V	18	MHz
		C <sub>L</sub> = 20 pF, G = 0.5 V/V	6	MHz
		C <sub>L</sub> = 20 pF, G = 1 V/V	4	MHz
BW	Bandwidth	C <sub>L</sub> = 20 pF, G = 2 V/V	3	MHz
		$C_L = 20 \text{ pF}, \text{ G} = 4 \text{ V/V}$	2.5	MHz
		C <sub>L</sub> = 20 pF, G = 8 V/V	2.1	MHz
		$C_{L} = 20 pF, G = 16 V/V$	1.85	MHz
		C <sub>L</sub> = 20 pF, G = 32 V/V	1.55	MHz
RX_PG	A2 INPUT			
	Input voltage range	For linear operation	(A <sub>GND</sub> + 0.15) / (AVDD - 0.15)/ gain gain	V
		G = 1 V/V	54	kΩ
RI	Input resistance	G = 4 V/V	21	kΩ
		G = 16 V/V	5.5	kΩ



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## **ELECTRICAL CHARACTERISTICS: Receiver (continued)**

At  $T_{CASE}$  = +25°C,  $V_{PAVS}$  = 15 V, and  $V_{AVDD}$  =  $V_{DVDD}$  = 3.3 V, unless otherwise noted.

	PARAME	ΓER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Rx_PG	GA2 GAIN						
G	Gain				1, 4, 16		V/V
G <sub>E</sub>	Gain error		For all gains, $T_J = -40^{\circ}C$ to $+125^{\circ}C$	-2%		2%	
	Gain error drift		$T_{\rm J} = -40^{\circ}{\rm C} \text{ to } +125^{\circ}{\rm C}$		±100		ppm/°C
RX_PG	GA2 FREQUENCY RE	SPONSE					
			$C_L = 20 \text{ pF}, \text{ G} = 1 \text{ V/V}$		6.73		MHz
BW	Bandwidth		$C_L = 20 \text{ pF}, \text{ G} = 4 \text{ V/V}$		5		MHz
			C <sub>L</sub> = 20 pF, G = 16 V/V		3		MHz
RX_PG	GA2 OUTPUT						
	Output resistance		G = 1, f = 100 kHz		1		kΩ
RX PA	TH SENSITIVITY <sup>(1)</sup>						
		CEN-A	35 kHz to 95 kHz		10		$\mu V_{RMS}$
		CEN-B	95 kHz to 125 kHz		5		μV <sub>RMS</sub>
		CEN-C	125 kHz to 140 kHz		3		$\mu V_{RMS}$
	Input-referred integrated noise	CEN-D	140 kHz to 148 kHz		2		$\mu V_{RMS}$
		ARIB STD-T84	35kHz to 400 kHz		12		$\mu V_{RMS}$
		FCC-LOW	35 kHz to 125 kHz		11		$\mu V_{RMS}$
		G3-FCC	150 kHz to 490 kHz		10		μV <sub>RMS</sub>

(1) Noise-reducing capacitor = 1 nF from TX\_RX\_NRF to ground, RX\_PGA1 = 32, and RX\_PGA2 = 1.

## **ELECTRICAL CHARACTERISTICS: Noise-Reducing Filters**

## At $T_{CASE}$ = +25°C, $V_{PAVS}$ = 15 V, and $V_{AVDD}$ = $V_{DVDD}$ = 3.3 V, unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT
PA_NRF	•			+	
	Bias voltage		V <sub>PAV S</sub> / 2		V
R <sub>OUT</sub>	Output resistance		4		kΩ
t <sub>ON</sub>	Turn-on time	Noise-reducing capacitor = 1 nF from PA_NRF to ground	250		ms
t <sub>OFF</sub>	Turn-off time		10		μs
TX_RX_	NRF			·	
	Bias voltage		V <sub>AVDD</sub> / 2		V
R <sub>OUT</sub>	Output resistance		1		kΩ
t <sub>ON</sub>	Turn-on time	Noise-reducing capacitor = 1 nF from TX_RX_NRF to ground	10		μs
t <sub>OFF</sub>	Turn-off time		10		μs
DAC_NF	RF			·	
	Bias voltage		V <sub>AVDD</sub> / 4.7		V
R <sub>OUT</sub>	Output resistance		1		kΩ
t <sub>ON</sub>	Turn-on time	Noise-reducing capacitor = 1 nF from DAC_NRF to ground	10		μs
t <sub>OFF</sub>	Turn-off time		10		μs

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# ELECTRICAL CHARACTERISTICS: Digital

At  $T_{CASE}$  = +25°C,  $V_{PAVS}$  = 15 V, and  $V_{AVDD}$  =  $V_{DVDD}$  = 3.3 V, unless otherwise noted.

	PARAMETE	R	TEST CONDITIONS	MIN	TYP MAX	UNIT
DIGITA	L INPUTS (SCLK, DI, CS, S	SD, DAC, XCLK)				
	Leakage input current		$0 V \leq V_{IN} \leq DVDD$	-1	0.01 1	μA
V <sub>IH</sub>	High-level input voltage	e		0.7 × DVDD		V
V <sub>IL</sub>	Low-level input voltage	)			0.3 × DVDD	V
	SD pin function	SD pin high	SD > 0.7 × DVDD	Dev	vice in shutdown	
	(active high)	SD pin low	SD < 0.3 × DVDD	Device	in normal operation	1
	DAC pin function	DAC pin high	DAC > 0.7 × DVDD	SPI acc	ess to DAC register	s
	(active high)	DAC pin low	DAC < 0.3 × DVDD	SPI access to c	SPI access to command and data	
	XCLK frequency range	•	XCLK jitter < 180 ps	5	40	MHz
DIGITA	L OUTPUTS (DO, ZC_OUT	)				
V <sub>OH</sub>	High-level output volta	ge	I <sub>OH</sub> = 3 mA	DVDD - 0.4	DVDD	V
V <sub>OL</sub>	Low-level output voltage	je	$I_{OL} = -3 \text{ mA}$	GND	GND + 0.4	V
DIGITA	L OUTPUTS (INT, TX_FLA	G, RX_FLAG)				
I <sub>OH</sub>	High-level output curre	nt	V <sub>OH</sub> = 3.3 V		1	
V <sub>OL</sub>	Low-level output voltage	je	I <sub>OL</sub> = 4 mA		0.4	V
I <sub>OL</sub>	Low-level output current	nt	V <sub>OL</sub> = 400 mV	4		mA
	INT pin (active low,	INT pin high	INT sink high < 1 μA	No	ormal operation	
	open-drain)	INT pin low	INT < 0.4 V	Inter	rupt has occurred	
	TX FLAG (active low,	TX_FLAG pin high	TX_FLAG sink high < 1 μA	Tx	block disabled	
	open-drain)	TX_FLAG pin low	TX_FLAG < 0.4 V	Т	x block ready	
	RX_FLAG (active	RX_FLAG pin high	RX_FLAG sink high < 1 μA	Rx	block disabled	
	low, open-drain)	RX_FLAG pin low	RX_FLAG < 0.4 V	R	x block ready	
GAIN T	IMING					
	Gain select time				0.2	μs
SHUTD	OWN MODE TIMING					
	Enable time		SD pin transitions from high to low		3	ms
	Disable time		SD pin transitions from low to high		2	
POR TI	MING				4	
	Power-on reset power-	up time	DVDD ≥ 2 V		3	ms



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# ELECTRICAL CHARACTERISTICS: Zero-Crossing Detector

At  $T_{CASE}$  = +25°C,  $V_{PAVS}$  = 15 V, and  $V_{AVDD}$  =  $V_{DVDD}$  = 3.3 V, unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	Input voltage range		AGND		AVDD	V
	Input current range		-10		10	mA
R <sub>IN</sub>	Input resistance	$AGND \le V_{IN} \le AVDD$		2		MΩ
C <sub>IN</sub>	Input capacitance			4	1.35	pF
	Rising threshold		0.45	0.9		V
	Falling threshold		0.25	0.5	0.75	V
	Hysteresis		0.2	0.4	0.6	V
	Jitter	50 Hz and 60 Hz, 240 $V_{\text{RMS}}$ and 120 $V_{\text{RMS}}$		10		ns

## ELECTRICAL CHARACTERISTICS: Power Supply

At  $T_{CASE} = +25^{\circ}C$ ,  $T_{J} = -40^{\circ}C$  to  $+125^{\circ}C$ ,  $V_{PAVS} = 15$  V, and  $V_{AVDD} = V_{DVDD} = 3.3$  V, unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OPERATI	NG SUPPLY RANGE				I	
PA_VS	Power amplifier		7	15	24	V
DVDD	Digital supply			3.3		V
AVDD	Analog supply			3.3		V
QUIESCE	NT CURRENT (SD pin	low)				
		I <sub>O</sub> = 0 V, PA = on <sup>(1)</sup> , REG_PA_CURRENT_CFG[7:6] = 00	40	48	56	mA
IQ <sub>PA_VS</sub>	D	I <sub>O</sub> = 0 V, PA = on <sup>(1)</sup> , REG_PA_CURRENT_CFG[7:6] = 01	68	78	88	mA
	Power amplifier	I <sub>O</sub> = 0 V, PA = on <sup>(1)</sup> , REG_PA_CURRENT_CFG[7:6] = 10	84	96	108	mA
		I <sub>O</sub> = 0 V, PA = on <sup>(1)</sup> , REG_PA_CURRENT_CFG[7:6] = 11	10	17	24	mA
		Tx configuration <sup>(2)</sup>	1.5	2.5	3.5	mA
IQ <sub>DVDD</sub>	Digital supply	Rx configuration <sup>(3)</sup>	1.1	2.1	3.1	mA
		All blocks disabled <sup>(4)</sup>		330	450	μA
		Tx configuration <sup>(3)</sup>	8	11	14	mA
IQ <sub>AVDD</sub>	Analog supply	Rx configuration <sup>(4)</sup>	9	13	17	mA
		All blocks disabled <sup>(4)</sup>		25	100	μA
SHUTDO	WN					
SD <sub>PA_VS</sub>	Power amplifier	SD pin high		40	150	μA
SD <sub>DVDD</sub>	Digital supply	SD pin high		330	400	μA
SD <sub>AVDD</sub>	Analog supply	SD pin high		25	50	μA

(1) PA and PA output enabled.

(2) The DAC, TX\_PGA, low-pass filter, PA, PA\_NRF, TX\_RX\_NRF, and DAC\_NRF blocks are enabled in the Tx configuration. All other blocks are disabled.

(3) The RX\_PGA1, high-pass filter, low-pass filter, RX\_PGA2, and TX\_RX\_NRF blocks are enabled in the Rx configuration. All other blocks are disabled.

(4) All internal blocks disabled, SD pin low.

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## **SPI TIMING REQUIREMENTS**

	PARAMETER	MIN	TYP	MAX	UNIT
	Input capacitance		1		pF
t <sub>RFI</sub>	Input rising and falling time ( $\overline{CS}$ , DIN, SCLK)			2	ns
t <sub>RFO</sub>	DOUT rising and falling time			10	ns
t <sub>CSH</sub>	CS high time	10			DAC_CLK cycles <sup>(1)</sup>
t <sub>CS0</sub>	SCLK edge to $\overline{CS}$ falling edge setup time	10			ns
t <sub>CSSC</sub>	CS falling edge to first SCLK edge setup time	10			ns
f <sub>SCLK</sub>	SCLK frequency		20	30	MHz
t <sub>HI</sub>	SCLK high time	16.7	25		ns
t <sub>LO</sub>	SCLK low time	16.7	25		ns
t <sub>SCCS</sub>	SCLK last edge to $\overline{CS}$ rising edge setup time	10			ns
t <sub>CS1</sub>	CS rising edge to SCLK edge setup time	10			ns
t <sub>SU</sub>	DIN setup time	5			ns
t <sub>HD</sub>	DIN hold time	5			ns
t <sub>DO</sub>	SCLK to DOUT valid propagation delay			16	ns
t <sub>soz</sub>	CS rising edge to DOUT forced to Hi-Z			20	ns

(1)  $\overline{\text{CS}}$  pin must remain high for at least ten DAC\_CLK cycles after a write operation and must remain high for at least five DAC\_CLK cycles after a read operation.





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## TIMING DIAGRAMS

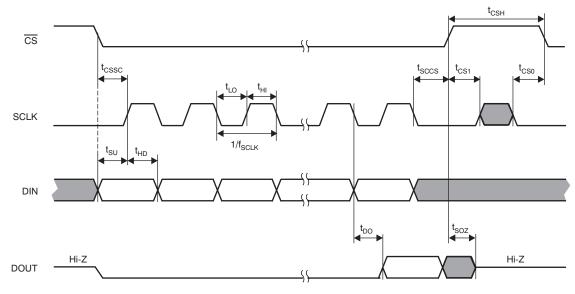


Figure 1. SPI Mode 0,0

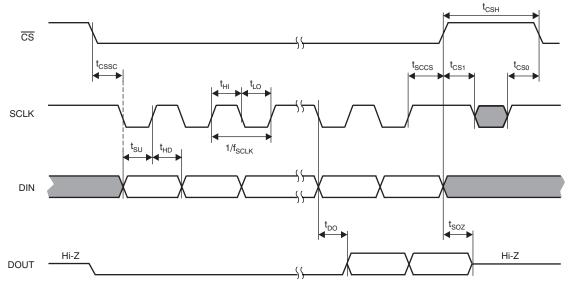
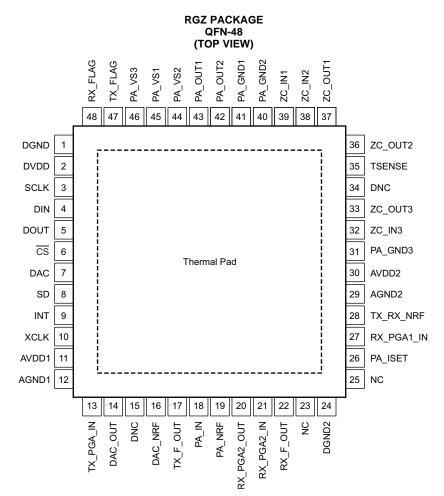


Figure 2. SPI Mode 1,1

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### **PIN CONFIGURATION**

NOTE: Connect exposed thermal pad to ground.

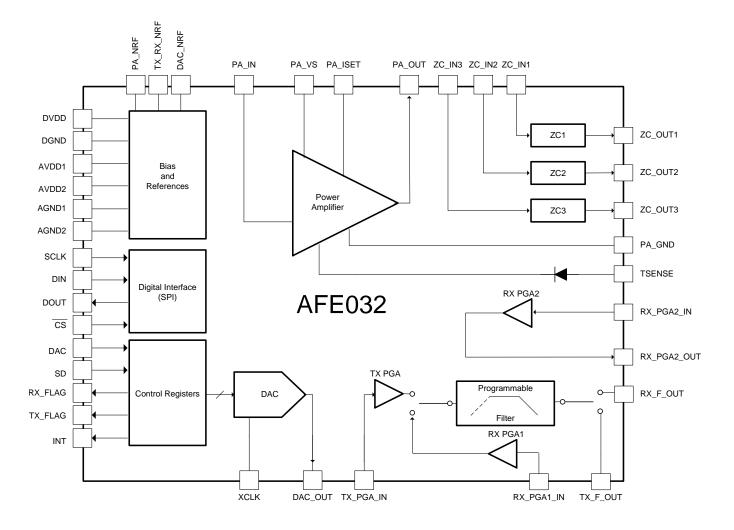


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#### **PIN DESCRIPTIONS**

NAME	PIN NO.	DESCRIPTION
AGND1	12	Analog ground
AGND2	29	Analog ground
AVDD1	11	Analog supply
AVDD2	30	Analog supply
CS	6	SPI digital chip-select input
DAC	7	DAC mode select digital input
DAC_OUT	14	DAC analog output
 DAC_NRF	16	DAC noise-reducing filter analog input
DGND	1	Digital ground
DGND2	24	Digital ground
DIN	4	SPI digital input
DNC	15, 34	Do not connect
DOUT	5	SPI digital output (push or pull)
DVDD	2	Digital supply
INT	9	Interrupt on undervoltage, undercurrent, or thermal overload (digital output, open-drain, active low)
NC	23, 25	No internal connection (connect to GND or leave unconnected)
PA_GND1	41	Power amplifier ground
_	41	
PA_GND2 PA_GND3	31	Power amplifier ground (connect to PA_GND1, pin 41) Power amplifier ground (connect to PA_GND1, pin 41)
_		
PA_IN	18	Power amplifier analog input
PA_ISET	26	Power amplifier current-limit adjust pin (left open if not used)
PA_NRF	19	Power amplifier noise-reducing filter analog input
PA_OUT1	43	Power amplifier output
PA_OUT2	42	Power amplifier output (connect to PA_OUT1, pin 43)
PA_VS1	45	Power amplifier supply
PA_VS2	44	Power amplifier supply (connect to PA_VS1, pin 45)
PA_VS3	46	Power amplifier supply (connect to PA_VS1, pin 45)
RX_F_OUT	22	Receiver filter analog output
RX_FLAG	48	Receiver ready flag (digital output, open-drain, active low)
RX_PGA1_IN	27	Receiver PGA1 analog input
RX_PGA2_IN	21	Receiver PGA2 analog input
RX_PGA2_OUT	20	Receiver PGA2 analog output
SCLK	3	SPI serial clock input
SD	8	System shutdown digital input (active high)
TSENSE	35	Analog temperature sensing diode (anode)
TX_F_OUT	17	Transmit filter analog output
TX_FLAG	47	Transmitter ready flag (digital output, open-drain, active low)
TX_PGA_IN	13	Transmitter PGA analog input
TX_RX_NRF	28	Transmitter and receiver noise-reducing filter analog input
XCLK	10	DAC clock digital input
ZC_IN1	39	Zero-crossing detector 1, analog input
ZC_IN2	38	Zero-crossing detector 2, analog input
ZC_IN3	32	Zero-crossing detector 3, analog input
ZC_OUT1	37	Zero-crossing detector 1, digital output (push or pull)
ZC_OUT2	36	Zero-crossing detector 2, digital output (push or pull)
ZC_OUT3	33	Zero-crossing detector 3, digital output (push or pull)

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# FUNCTIONAL BLOCK DIAGRAM



କ୍ରି -20

-40

-50

-60

1000

Gain -30

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# www.ti.com **TYPICAL CHARACTERISTICS** 10 0 -10

90 kHz (CENELEC A)

420 kHz (ARIB)

490 kHz (FCC)

10k

140 kHz (CENELEC B to D)

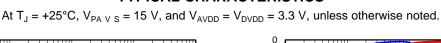
100k

Frequency (Hz)

Figure 3. Tx, Rx LOW-PASS FILTER GAIN vs FREQUENCY

1M

10M



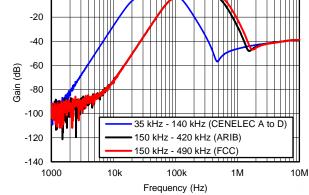
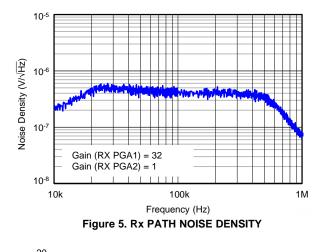
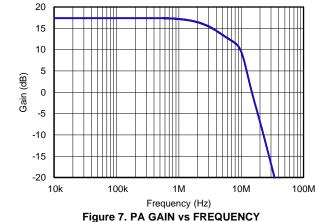
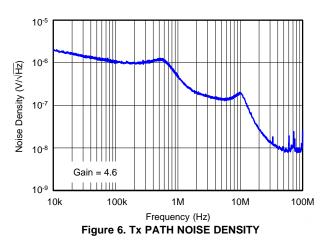
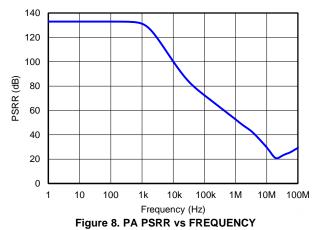


Figure 4. Rx BAND-PASS FILTER GAIN vs FREQUENCY

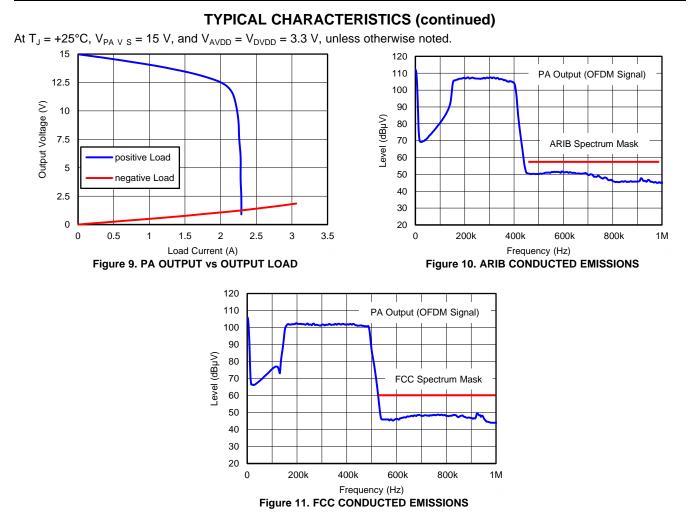








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## **APPLICATION INFORMATION**

## **GENERAL DESCRIPTION**

The AFE032 is an integrated, power-line communication, analog front-end device that functions in conjunction with a microcontroller. The device conditions data generated in a microcontroller and transmits such data onto power lines through a line-coupling circuit.

The device includes several primary functional blocks:

- A power amplifier (PA) transmits data onto power lines through a line-coupling circuit.
- The transmit path (Tx) consists of a high-precision, digital-to-analog converter (DAC), programmable amplifier (TX\_PGA), and low-pass filter (LPF).
- The receive path (Rx) consists of two programmable amplifiers (RX\_PGA1 and RX\_PAG2) and a band-pass filter [(an LPF and a high-pass filter (HPF)].

## **BLOCK DESCRIPTIONS**

#### **Power Amplifier Block**

The power amplifier (PA) block consists of a high slew rate, high-voltage, and high-current operational amplifier. The PA is configured with an inverting gain of 7 V/V, has a low-pass filter response, and maintains excellent linearity and low distortion throughout its bandwidth. The PA is specified to operate from 7 V to 24 V and can deliver up to  $\pm 1.9$  A of continuous output current over the specified junction temperature range of  $-40^{\circ}$ C to  $\pm 125^{\circ}$ C. The PA block is shown in Figure 12.

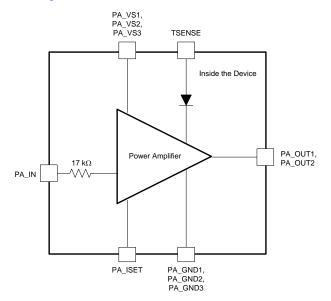


Figure 12. PA Block Equivalent Circuit

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Connecting the PA in a typical power line communication (PLC) application requires few additional components. Figure 13 shows the typical connections to the PA block.

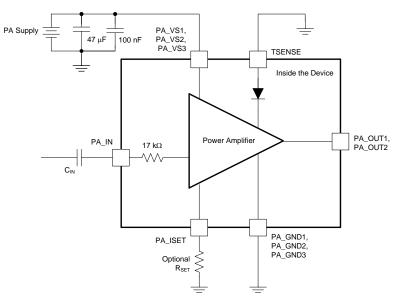


Figure 13. Typical Connections to the PA

The external capacitor ( $C_{IN}$ ) introduces a single-pole, high-pass characteristic to the PA transfer function. The  $C_{IN}$  and PA combination has a band-pass response because of the inherent low-pass transfer function from the PA. The value of the high-pass cutoff frequency is determined by  $C_{IN}$  reacting with the input resistance of the PA circuit, and can be determined by Equation 1:

$$C_{IN} = \frac{1}{2 \times \pi \times 18 \text{ k}\Omega \times f_{HP}}$$

where:

- C<sub>IN</sub> = external input capacitor and
- f<sub>HP</sub> = desired high-pass cutoff frequency.

For example, setting  $C_{IN}$  to 3.3 nF results in a high-pass cutoff frequency of 2.9 kHz. The voltage rating for  $C_{IN}$  should be determined to withstand operation up to the PA power-supply voltage.

When the transmitter is not in use, the output can be disabled and placed in a high-impedance state by following the procedure outlined in the *Power Amplifier Enable Sequence* section.

Refer to the *Initialization Sequence* and *Power Amplifier Enable Sequence* sections for details on the proper sequence when enabling the power amplifier.



AFE032

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#### PA Current Limiting

The PA\_ISET pin (pin 26) provides a resistor-programmable output current limit for the PA block. Equation 2 determines the value of the external  $R_{SET}$  resistor attached to this pin.

$$I_{\text{LIM}} = \frac{1.2 \text{ V} \times 16.320 \text{ k}\Omega}{\text{R}_{\text{INT}} + \text{R}_{\text{SET}}}$$

where:

- R<sub>SET</sub> = the value of the external resistor connected between pin 26 and ground,
- R<sub>INT</sub> = the value of the internal resistor as programmed by the SPI interface in Table 18 (bits 4 and 5), and
- I<sub>lim</sub> = the value of the desired current limit for the PA.

R<sub>INT</sub> bit setting for bits 4 and 5 in Table 18 are listed in Table 1.

BIT SETTING	R <sub>INT</sub> VALUE					
00	17 kΩ					
01	11 kΩ					
10	8 kΩ					
11	1.2 kΩ					

Table 1. R <sub>INT</sub> Bit Set	tings
-----------------------------------	-------

Note that there is a 30% tolerance on the I<sub>lim</sub> value given by Equation 2.

#### Tx Block

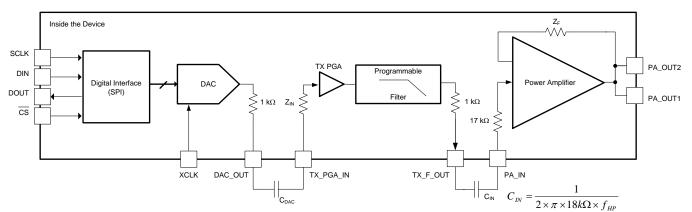
The Tx block consists of the Tx PGA and Tx filter.

The Tx PGA is a low-noise, high-performance, programmable gain amplifier. In DAC mode [where the DAC pin, pin 7, is a logic '1' and Tx enable (bit 4 in the REG\_RX/TX\_CTL register) is a logic '1'], the Tx PGA operates as the internal digital-to-analog converter (DAC) output buffer with programmable gain. The Tx PGA gain is programmed through the serial interface. The Tx PGA gain settings are 1.15 V/V, 2.3 V/V, 3.25 V/V, and 4.6 V/V. Gain is selectable via the TX\_PGA gain pins (bits 2 to 0 in the REG\_RX/TX\_CTL register).

The Tx filter is a unity-gain, fourth-order, low-pass filter. The Tx filter cutoff frequency is selectable between the CENELEC (bands A, B, C, or D), ARIB, or FCC modes. The LPF band select bits (bits 6 to 4 in the REG\_HPF/LPF\_CFG register) determine the cutoff frequency.

When in DAC mode, the device accepts serial data from the microprocessor and writes that data to the internal DAC registers.

Proper connections for the Tx signal path for DAC mode operation are shown in Figure 14.



(1) For the capacitor value of  $C_{IN}$ ,  $f_{HP}$  is the desired lower cutoff frequency and 17 k $\Omega$  is the PA input resistance.

## Figure 14. Recommended Tx Signal Chain Connections



The capacitors listed in Figure 14 should be rated to withstand the full AVDD power-supply voltage for  $C_{DAC}$  and PA\_VS for  $C_{IN}$ .

### **Rx Block**

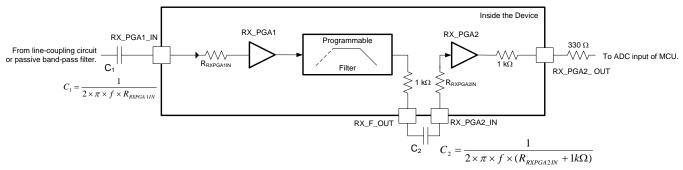
The Rx block consists of the Rx PGA1, Rx filter, and Rx PGA2. Both Rx PGA1 and Rx PGA2 are high-performance programmable gain amplifiers that can be configured through the SPI interface.

Rx PGA1 can operate as either an attenuator or in gain. The Rx PGA1 gain steps are 0.125 V/V, 0.25 V/V, 0.5 V/V, 1 V/V, 2 V/V, 4 V/V, 8 V/V, 16 V/V, and 32 V/V. Gains are selectable with the RX\_PGA1 gain bits (bits 7 to 4 in the REG\_RXPGA\_CFG register). Configuring the Rx PGA1 as an attenuator (at gains less than 1 V/V) is useful for applications where large interference signals are present within the signal band. Attenuating the large interference allows these signals to pass through the analog Rx signal chain without causing an overload; the interference signal can then be processed and removed within the microprocessor as necessary. Similarly, if a transmitter is located close to the receiver, gains less than 1 V/V may be needed.

The Rx PGA2 gain steps are 1 V/V, 4 V/V, and 16 V/V. Gains are selectable through the RX\_PGA2 gain bits (bits 3 to 1 in the REG\_RXPGA\_CFG register).

The Rx filter is a very low-noise, unity-gain, fourth-order, low-pass or band-pass filter. The Rx filter cutoff frequency is selectable between the CENELEC (bands A, B, C, or D), ARIB, or FCC modes. The LPF band select bits (bits 6 to 4 of the REG\_HPF/LPF\_REG register) determine the cutoff frequency for the LPF. The HPF band select bits (bits 1 and 2 of the REG\_HPF/LPF\_REG register) set up the cutoff frequency of the HPF.

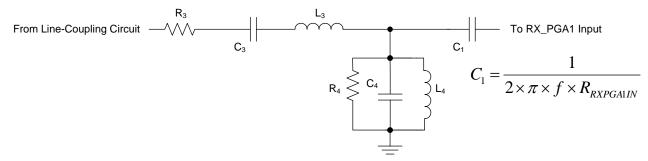
Recommended connections for the Rx signal chain are shown in Figure 15.



- (1) For capacitor value C<sub>1</sub>, f is the desired lower cutoff frequency and R<sub>RXPAG1IN</sub> is the input resistance of RX\_PGA1.
- (2) For capacitor value C<sub>2</sub>, f is the desired lower cutoff frequency and R<sub>RXPAG2IN</sub> is the input resistance of RX\_PGA2.

#### Figure 15. Recommended Connections for Rx Signal Chain

Figure 16 shows, a fourth-order, passive band-pass filter that is optional but recommended for applications with high performance needs. The external passive band-pass filter removes unwanted, out-of-band signals from the signal path, and it prevents such signals from reaching the active internal filters within the device.



(1) For capacitor value  $C_1$ , f is the desired lower cutoff frequency and  $R_{RXPGA1IN}$  is the input resistance of RX\_PGA1.

#### Figure 16. Passive Band-Pass Rx Filter



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The following steps can be used to quickly design the passive pass-band filter. (Note that these steps produce an approximate result.)

- 1. Choose the filter characteristic impedance,  $Z_C$ :
  - For a –6-db passband attenuation:  $R_3 = R_4 = Z_C$ .
  - For a 0-db passband attenuation:  $R_4 = Z_C$ ,  $R_3 = 10 \times Z_C$ .
- 2. Calculate values for  $C_3$ ,  $C_4$ ,  $L_3$ , and  $L_4$  using the following equations:

$$C_{3} = \frac{1}{2 \times \pi \times f_{3} \times Z_{C}}$$

$$C_{4} = \frac{1}{2 \times \pi \times f_{4} \times Z_{C}}$$

$$L_{3} = \frac{Z_{C}}{2 \times \pi \times f_{3}}$$

$$L_{4} = \frac{Z_{C}}{2 \times \pi \times f_{4}}$$

Table 2 and Table 3 show standard values for common applications.

# Table 2. Recommended Component Values for Fourth-Order Passive Band-Pass Filters (0-dB Pass-Band Attenuation)

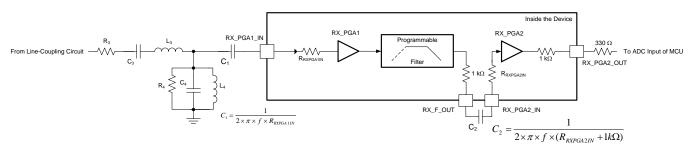
FREQUENCY BAND	FREQUENCY RANGE (kHz)	CHARACTERISTIC IMPEDANCE	R3	R4 (kΩ)	C3 (nF)	C4 (nF)	L3 (µH)	L4 (µH)
CENELEC A	35 to 95	1 kΩ	1 kΩ	10	4.7	1.5	1500	4700
CENELEC B, C, D	95 to 150	1 kΩ	1 kΩ	10	1.7	1	1200	1500
SFSK	63 to 74	1 kΩ	1 kΩ	10	2.7	2.2	2200	2200
FCC and ARIB	15 to 600	100 Ω	100 Ω	1	100	2.2	27	1000

#### Table 3. Recommended Component Values for Fourth-Order Passive Band-Pass Filters (-6-dB Pass-Band Attenuation)

FREQUENCY BAND	FREQUENCY RANGE (kHz)	CHARACTERISTIC IMPEDANCE	R3	R4	C3 (nF)	C4 (nF)	L3 (µH)	L4 (μΗ)
CENELEC A	35 to 95	1 kΩ	1 kΩ	1 kΩ	4.7	1.5	1500	4700
CENELEC B, C, D	95 to 150	1 kΩ	1 kΩ	1 kΩ	1.7	1	1200	1500
SFSK	63 to 74	1 kΩ	1 kΩ	1 kΩ	2.7	2.2	2200	2200
FCC and ARIB	15 to 600	100 Ω	100 Ω	100 Ω	100	2.2	27	1000

Avoid excessive capacitive loading when laying out the printed circuit board (PCB) traces from the inputs or outputs of the Rx block components. Keeping the PCB capacitance from the inputs to ground, or outputs to ground, below 100 pF is recommended.

Figure 17 shows the complete Rx signal path, including the optional passive band-pass filter.



- (1) For capacitor value  $C_1$ , f is the desired lower cutoff frequency and  $R_{RXPGA1IN}$  is the input resistance of RX\_PGA1.
- (2) For capacitor value C<sub>2</sub>, f is the desired lower cutoff frequency and R<sub>RXPGA2IN</sub> is the input resistance of RX\_PGA2.

## Figure 17. Complete Rx Signal Path (with Optional Band-Pass Filter)

## DAC Block and DSP Path

The AFE032 contains a digital signal processing (DSP) path that receives incoming DAC samples delivered from an external processor, conditions each sample, and delivers these samples to a 12-bit DAC. The device serial interface is used to write directly to the DSP path when the DAC pin (pin 7) is driven high. Use the following sequence to write samples to the DAC:

- Send a valid XCLK signal to the device (refer to the *AFE032 Clock Requirements* section for more details on the XCLK signal).
- Set CS low.
- Wait 20 DAC\_CLK cycles (refer to the *AFE032 Clock Requirements* section for more details on the relationship between the XCLK frequency and DAC\_CLK frequency).
- Set the DAC pin (pin 7) high to configure the device in DAC mode.
- Write a 12-bit word to DIN. <sup>(1)</sup> Note that the DAC register is left-justified.
- Set  $\overline{\text{CS}}$  high to indicate that the sample is entered.

Refer to the *DAC Mode* section for more details on using the device in DAC mode.

The full-scale DAC output swing equals the DAC\_NRF voltage level. Table Table 4 shows the ideal dc DAC output voltage for a given input code.

INPUT CODE (Hex)	IDEAL DAC OUTPUT VOLTAGE (V)
7FF	DAC_NRF bias voltage
001	[(DAC_NRF bias voltage) / (2 <sup>12</sup> – 1)] + (DAC_NRF bias voltage) / 2
000	(DAC_NRF bias voltage) / 2
FFF	[(DAC_NRF bias voltage) / 2] – (DAC_NRF bias voltage) / (2 <sup>12</sup> – 1)
800	0

## Table 4. Ideal DAC Output

(1) The only exception to the 12-bit DAC sample length is when using a 16-bit envelope. See the SPI Envelope Exception Case section for more details.

## DAC\_NRF, PA\_NRF, and TX\_RX\_NRF Blocks

The DAC\_NRF, PA\_NRF, and TX\_RX\_NRF blocks create biasing points used internally to the device. Each reference divides its respective power-supply voltage with a precision resistive voltage divider. PA\_NRF provides a PA\_VS / 2 voltage used for the PA; TX\_RX\_NRF provides an AVDD / 2 voltage used for the Tx PGA, Tx filter, Rx PGA1, Rx filter, and Rx PGA2; and DAC\_NRF provides an AVDD / 4.7 voltage used for the DAC. Each NRF block has its output brought out to an external pin that can be used for filtering and noise reduction. These capacitors are optional, but are recommended for best performance.



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#### Zero-Crossing Detector Block

The device includes three zero-crossing detectors. Zero-crossing detectors can be used to synchronize communications signals to the ac line or sources of noise. Typically, in single-phase applications, only a single zero-crossing detector is used. In three-phase applications, two or three zero-crossing detectors can be used. Figure 18 shows the AFE032 configured for non-isolated, zero-crossing detection.

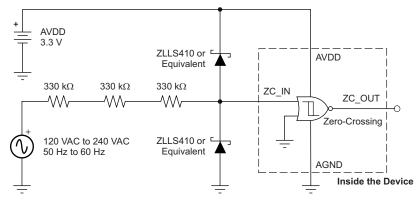


Figure 18. Non-Isolated Zero-Crossing Detection Using the AFE032

Non-isolated zero-crossing waveforms are shown in Figure 19.

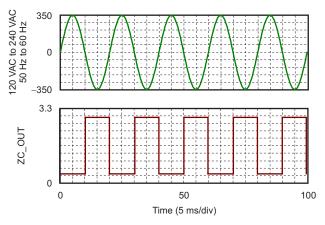


Figure 19. Non-Isolated, Zero-Crossing Waveforms



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Schottky diodes are recommended (see Figure 18) for maximum device protection from line transients. These diodes limit the ZC\_IN pins (pins 32, 38, and 39) to within the maximum rating of (AVDD + 0.4 V) and (AGND - 0.4 V). Some applications may require an isolated zero-crossing detection circuit. With a minimal amount of components, the AFE032 can be configured for isolated zero-crossing detection, as shown in Figure 20.

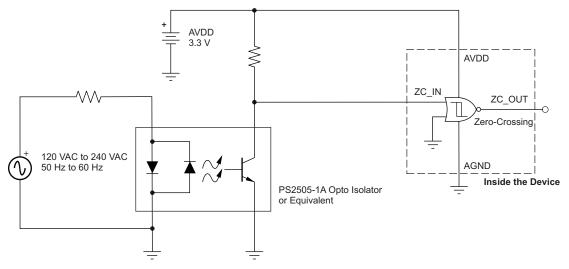


Figure 20. Isolated Zero-Crossing Detection Using the AFE032

Isolated zero-crossing waveforms are shown in Figure 21.

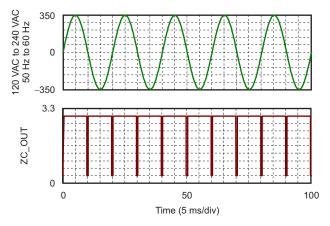


Figure 21. Isolated Zero-Crossing Waveforms



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### DIGITAL LOGIC INTERFACE

The primary functions of the AFE032 digital module are to:

- Provide an interface for an external DSP to configure the internal blocks of the AFE032.
- Provide a digital processing path that conditions samples coming from an external DSP.
- Transmit the conditioned samples to the internal 12-bit DAC.

To accomplish these functions, the device digital logic supports two modes of operation: SPI mode and DAC mode.

In SPI mode, the device processes commands to either configure the internal analog and digital circuits or to provide status to an external DSP. In DAC mode, an external DSP uses the SPI to provide DAC samples to the device.

Descriptions of all the registers mentioned in this section can be found in the *Register Map* section.

#### **AFE032 Clock Requirements**

The device requires the following clocks: XCLK and SCLK.

XCLK is a free-running clock with a 50/50 duty cycle, frequency ranges from 10 MHz to 40 MHz, and less than 180 ps of RMS jitter. SCLK is an SPI clock used for the SPI interface with frequency ranges from 14 MHz to 30 MHz. This clock is active when CS is '0'.

The device contains two programmable clock dividers that can be used to generate the internal DAC clock (referred to as *DAC\_CLK*). This internal DAC clock determines the rate at which the internal device DAC updates its analog output. The internal DAC clock is also used by the digital logic in the device (with the exception of the SPI slave module that requires a separate SCLK signal). The REG\_CLK\_DIV register is programmed by the user to control the internal DAC clock frequency. The internal DAC clock is created by two 4-bit clock dividers in series. Each divider is a 4-bit decimal clock divider that can divide the frequency of the XCLK signal by an integer between 1 and 16. Each clock divider produces an N+1 divided-down clock, where *N* is the programmed, 4-bit divide value. The XCLK frequency can be divided by a maximum value of 256. The first divider in the series is controlled by the POST\_CLK\_DIV bits (bits 7 to 4 in the REG\_CLK\_DIV register) and the second divider is controlled by the PRE\_CLK\_DIV bits (bits 3 to 0 in the REG\_CLK\_DIV register). If the application does not need to divide XCLK by a value greater than 16, then POST\_CLK\_DIV is not programmed because these bits default to '0'. For applications where XCLK must be divided down by a number greater than 16, both PRE\_CLK\_DIV and POST\_CLK\_DIV are used to create the target divide-down value required to generate DAC\_CLK. In sum, the relationship between XCLK and DAC\_CLK can be expressed as Equation 3:

XCLK = (POST\_CLK\_DIV + 1) (PRE\_CLK\_DIV + 1) (DAC\_CLK)

(3)

Note that for proper device operation, DAC\_CLK must always be slower than SCLK.

In DAC mode, an external processor (also referred to as the *SPI master* or *external DSP*) transmits DAC samples to the device via the SPI at a rate of  $f_S$  samples per second.  $f_S$  may be less than or equal to DAC\_CLK; however, the external processor clock and the AFE032 XCLK must be generated from the same crystal.

## Power-Up Sequence

A specific power-up sequence must be implemented to properly use the AFE032. The device internal blocks are disabled if proper VDD levels are not maintained. The following sequence applies at power-up (note that the SD pin must be held low throughout the entire power-up sequence):

- Power is applied to the device.
- When the supply connected to the AVDD1, AVDD2, and DVDD pins reaches a valid, 3-V dc voltage level, the device digital logic comes out of reset.
- At this point, a valid XCLK signal is sent to the device for at least 65,536 cycles.

Every time power is applied to the device, in addition to the power-up sequence, a complete initialization sequence must be followed before the user can transmit data with the power amplifier. The complete initialization sequence must be followed also after a soft reset is performed (see the AFE032 Reset Options section for more information on soft reset). The *Initialization Sequence* section provides more details. Similarly, perform a sequence each time the device transitions from receiver mode (also referred to as *RX mode*) to transmitter mode (also referred to as *TX mode*). The *Power Amplifier Enable Sequence* section provides more details for this Rx to Tx mode transition sequence.

# TEXAS INSTRUMENTS

# SPI Mode

Holding the DAC pin low places the device in SPI mode. The following rules apply to the SPI slave operation when the device is in SPI mode:

- Each SPI operation is 16 bits wide.
- The  $\overline{\text{CS}}$  pin is set to '0' for each 16-bit SPI operation.
- The  $\overline{CS}$  pin is set to '1' between consecutive SPI operations.
- A minimum of ten DAC\_CLK cycles must be inserted after a write operation and a minimum of five DAC\_CLK cycles must be inserted after a read operation. During these cycles, the CS pin is set to '1'.
- The device DIN pin value is latched in during the SCLK rising edge.
- The device drives DOUT on the SCLK falling edge.
- DOUT assumes a high-impedance state when CS is set to '1'.

During an SPI operation in SPI mode, the following protocol is applied to the DIN pin by the SPI master:

- The first bit of the operation is the read and write (R/W) bit. An SPI read is specified when an R/W bit is '1'. An SPI write is specified when an R/W bit is '0'.
- The next seven bits are the SPI address.
- The next eight bits are the SPI data.

Table 5 lists a complete example of the 16-bit codeword format.

# Table 5. 16-Bit Codeword Format for an SPI Operation in SPI Mode

BIT NAME	LOCATION (0 = LSB, 15 = MSB)	FUNCTION
DATA0	0	LSB of SPI data
DATA1	1	SPI data
DATA2	2	SPI data
DATA3	3	SPI data
DATA4	4	SPI data
DATA5	5	SPI data
DATA6	6	SPI data
DATA7	7	MSB of SPI data
ADDR0	8	LSB of register address bit
ADDR1	9	Register address bit
ADDR2	10	Register address bit
ADDR3	11	Register address bit
ADDR4	12	Register address bit
ADDR5	13	Register address bit
ADDR6	14	MSB of register address bit
R/W	15	Read or write: 0 = write, 1 = read

During an SPI operation, the following protocol is applied to the DOUT pin:

- If the current SPI operation from the master is a write operation, the AFE032 displays the previous operation received from the master on DOUT.
- If the current SPI operation from the master is a read operation, the AFE032 displays the R/W bit of the previous operation followed by the 7-bit address of the previous operation on DOUT. The remaining eight bits that follow depend on whether the previous operation was a read or write operation.
  - If a read request immediately follows a write operation, then the last eight bits are whatever was written to the device on DIN by the SPI master.
  - If a read request immediately follows a read operation, then the last eight bits are the contents of the AFE032 address used in the previous read operation.

Note that two SPI operations are required for the device to transmit status bits over the SPI. The first operation provides the AFE032 with the SPI register address to be read. The second operation transfers the data.



**AFE032** 

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A minimum of ten DAC\_CLK cycles must be inserted between consecutive write operations and a minimum of five DAC\_CLK cycles must be inserted between consecutive read operations.

## DAC Mode

The device digital logic contains four digital processing blocks to condition incoming DAC samples delivered from an external processor. The digital processing blocks in the device are referred to as the *DSP path*, as shown in Figure 22.

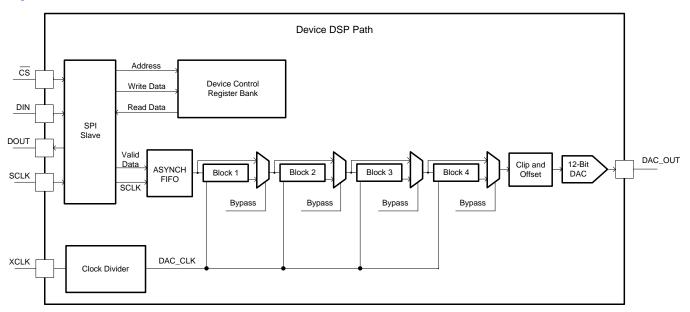


Figure 22. AFE032 DSP Path

Each block in the DSP path can be enabled or disabled to accommodate for different application scenarios. Processing DAC samples through the device can be broken down as follows:

- The device receives DAC samples (12 bits per sample) from an external DSP through the SPI at a rate of f<sub>S</sub> samples per second.
- The device receives the 12-bit samples and processes them as real signed numbers. Thus, bit 11 is processed as a sign bit. Therefore, the absolute value of each sample has 11 bits of resolution.
- The device extracts the DAC samples from the SPI and synchronizes them to DAC\_CLK through the ASYNCH FIFO.

## NOTE

The only exception to the 12-bit DAC sample length is when using a 16-bit envelope. See the *SPI Envelope Exception Case* section for more details.

When an external DSP is ready to send DAC samples to the device, the DAC\_MODE pin is asserted. The device digital logic reconfigures the SPI slave to run in a proprietary mode of operation in order to receive samples from the external DSP. In other words, the SPI interface becomes a write-only serial interface so that the external DSP can send DAC samples to the device. Each sample must be 12 bits wide.



The device digital logic sends valid samples to the DAC as long as the external DSP asserts the DAC\_MODE pin and sends 12-bit samples to the device. Note that whenever DAC\_MODE is not asserted, whichever values are present in the output stage of the DSP path continue to be driven to the DAC. Note also that, by default, all digital processing blocks in the device retain their states when DAC mode is deasserted (see the *DSP Path State Retention* section for more details). Use the following sequence to write samples to the DAC:

- 1. Send a valid XCLK signal to the device (refer to the *AFE032 Clock Requirements* section for more details on the XCLK signal).
- 2. Set CS low.
- 3. Wait for at least 20 DAC\_CLK cycles.
- 4. Set DAC (pin 7) high. This setting places the device in DAC mode.
- 5. Write the first 12-bit word to DIN. Note that the DAC register is left-justified.
- 6. Set  $\overline{\text{CS}}$  high to indicate that the sample is entered.
- 7. Wait for at least four SCLK cycles.
- 8. Set  $\overline{CS}$  low.
- 9. Write the subsequent 12-bit word to DIN. Note that the DAC register is left-justified.
- 10. Set  $\overline{CS}$  high for at least four SCLK cycles to indicate that the sample is entered.
- 11. Repeat the last three steps for each new DAC sample.

#### NOTE

The only exception to the 12-bit DAC sample length is when using a 16-bit envelope. See the *SPI Envelope Exception Case* section for more details.

Appending 24 mid-range value samples at the end of every transmission of DAC samples is recommended. These 24 samples provide a smooth transition of the entire transmit path (that is, <u>DSP</u> blocks, Tx PGA, and Tx filter) to SPI mode. When the transmission of the last DAC sample ends (and the <u>CS</u> pin is set high), wait for at least 20 DAC\_CLK cycles before bringing the DAC pin (pin 7) low.

## SPI Envelope Exception Case

Some external processors cannot create a 12-bit wide SPI transmission and output 16 bits. If this limitation is encountered, the device supports a special mode where a 12-bit DAC sample can be sent over the SPI inside a 16-bit window. To use the AFE032 16-bit SPI envelope feature take into account the following points:

- Set the DAC SPI select bit (bit 0 of the REG\_AFE032\_CTRL register) to '1'.
- Wait for at least 20 DAC\_CLK cycles after setting the DAC SPI select bit.
- Set the DAC pin (pin 7) high. This setting places the device in DAC mode.
- Drive the 12-bit DAC sample in the MSB position of the 16-bit SPI envelope.
- Provide 16 valid SCLK cycles in the SPI envelope.

The AFE032 SPI slave latches the first 12 bits and forwards them to the DSP path. The remaining four bits are dropped. When operating the device with the 16-bit SPI envelope enabled, the SPI must be driven exactly as described in this section or the device will not process the DAC samples successfully.

## **Digital Filtering**

Blocks 1 and 2 of the DSP path provide digital filtering to the samples generated by the external processor.

This section provides recommendations for the coefficient values for filter block 1 and filter block 2 of the DSP path. Three frequency bands are considered:

- CENELEC A band, comprised of frequencies between 3 kHz and 95 kHz.
- ARIB band, comprised of frequencies between 10 kHz and 450 kHz.
- FCC band, comprised of frequencies between 10 kHz and 490 kHz.

Note that the addresses of all registers mentioned in this section are given in the **REGISTER MAP** section.

Table 6 provides the recommended PRE\_CLK\_DIV and POST\_CLK\_DIV values of the REG\_CLK\_DIV register for the case of a 37.5 MHz XCLK frequency.

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## Table 6. Recommended Clock Divider Values for Different Frequency Bands and XCLK = 37.5 MHz

Frequency band	Clock divider value (decimal)	POST_CLK_DIV (Hex)	PRE_CLK_DIV (Hex)
CENELEC A	22	10	1
ARIB	7	0	6
FCC	7	0	6

Table 7 provides the recommended coefficient values (in hexadecimal form) for block 1.

## Table 7. Recommended Coefficient Values for Block 1 of DSP Path

Register	CENELEC A	ARIB	FCC
REG_COEFF1_BLOCK_1_MS	Disable	CC	A3
REG_COEFF1_BLOCK_1_LS	Disable	40	EO
REG_COEFF2_BLOCK_1_MS	Disable	E4	D8
REG_COEFF2_BLOCK_1_LS	Disable	50	EO
REG_COEFF3_BLOCK_1_MS	Disable	40	40
REG_COEFF3_BLOCK_1_LS	Disable	00	00
REG_COEFF4_BLOCK_1_MS	Disable	78	7E
REG_COEFF4_BLOCK_1_LS	Disable	40	80
REG_COEFF5_BLOCK_1_MS	Disable	40	40
REG_COEFF5_BLOCK_1_LS	Disable	00	00
REG_COEFF6_BLOCK_1_MS	Disable	30	17
REG_COEFF6_BLOCK_1_LS	Disable	C0	A0
REG_COEFF7_BLOCK_1_MS	Disable	15	3E
REG_COEFF7_BLOCK_1_LS	Disable	A0	D0

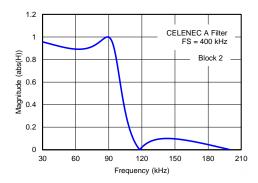
Table 8 provides the recommended coefficient values (in hexadecimal form) for block 2.

## Table 8. Recommended Coefficient Values for Block 2 of DSP Path

Register	CENELEC A	ARIB	FCC
REG_COEFF1_BLOCK_2_MS	10	F8	D4
REG_COEFF1_BLOCK_2_LS	40	30	00
REG_COEFF2_BLOCK_2_MS	00	00	00
REG_COEFF2_BLOCK_2_LS	00	00	00
REG_COEFF3_BLOCK_2_MS	0C	0C	0C
REG_COEFF3_BLOCK_2_LS	F0	B0	60
REG_COEFF4_BLOCK_2_MS	0C	0C	0C
REG_COEFF4_BLOCK_2_LS	F0	B0	60
REG_COEFF5_BLOCK_2_MS	00	00	00
REG_COEFF5_BLOCK_2_LS	00	00	00
REG_COEFF6_BLOCK_2_MS	06	C3	96
REG_COEFF6_BLOCK_2_LS	E0	80	20
REG_COEFF7_BLOCK_2_MS	D1	D0	СС
REG_COEFF7_BLOCK_2_LS	80	F0	70
REG_COEFF8_BLOCK_2_MS	0A	09	19
REG_COEFF8_BLOCK_2_LS	CO	20	A0
REG_COEFF9_BLOCK_2_MS	06	0D	30
REG_COEFF9_BLOCK_2_LS	00	C0	E0
REG_COEFF10_BLOCK_2_MS	0A	09	19
REG_COEFF10_BLOCK_2_LS	CO	20	A0
REG_COEFF11_BLOCK_2_MS	2D	60	3B
REG_COEFF11_BLOCK_2_LS	20	60	CO
REG_COEFF12_BLOCK_2_MS	69	6B	6E
REG_COEFF12_BLOCK_2_LS	60	90	80



Figure 23 shows the transfer function of block 2 when the recommended coefficients for the CENELEC A band are used.



#### Figure 23. Transfer Function of Block 2 - CENELEC A Band Coefficients According to Table 8

Figure 24 shows the transfer function of blocks 1 and 2 when the recommended coefficients for the ARIB band are used.

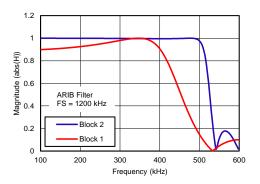
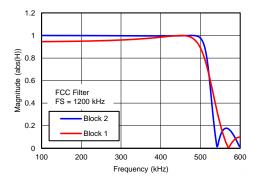


Figure 24. Transfer Function of Blocks 1 and 2 - ARIB Band Coefficients According to Table 7 and Table 8

Figure 25 shows the transfer function of blocks 1 and 2 when the recommended coefficients for the FCC band are used.





#### SPI Clock To DAC Clock Synchronization

The device receives DAC samples from the external DSP over the SPI (which operates using SCLK) and writes these samples to the ASYNCH FIFO for internal synchronization (the ASYNCH FIFO and the rest of the DSP path operate using the internally-generated DAC\_CLK signal). The FIFO read controller pulls the samples out of the ASYNCH FIFO at the rate determined by the DAC\_CLK frequency (not the rate determined by  $f_s$ ).



Refer to Figure 22 for the block diagram of the AFE032 DSP path. Bits 1 though 4 of the REG\_AFE032\_CTRL register determine which blocks are included in the DSP path and which are bypassed. The default values of these bits is '0' and all four blocks are included in the DSP path when the device is powered up.

Block 3 of the DSP path operates synchronously with DAC\_CLK and interpolates (by a factor of four) the signals coming from the ASYNCH FIFO. Such interpolation requires that samples stored in the ASYNCH FIFO be extracted no faster than one time every four DAC\_CLK cycles; such interpolation also imposes an upper bound to  $f_s$ . The external DSP must send samples to the device at a rate less than or equal to one-fourth the DAC\_CLK frequency [that is,  $f_s \leq (DAC_CLK / 4)$ ].

Block 4 should be used to improve performance in two cases:

- When block 3 is included in the DSP path and f<sub>S</sub> is strictly less than one-fourth the DAC\_CLK frequency [that is, f<sub>S</sub> < (DAC\_CLK / 4)].</li>
- When block 3 is bypassed (not included in the DSP path) and f<sub>S</sub> is strictly less than the DAC\_CLK frequency (that is, f<sub>S</sub> < DAC\_CLK).</li>

For these two cases, block 4 should be used and its 32-bit parameter should be written to the REG\_OFFSET0, REG\_OFFSET1, REG\_OFFSET2, and REG\_OFFSET3 registers. This section describes four typical scenarios that can be found in most applications.

#### Block 3 and Block 4 Are Bypassed

If an external DSP transmits DAC samples to the device at a rate equal to the DAC\_CLK frequency (that is,  $f_S = DAC_CLK$ ), then both block 3 and block 4 should be bypassed. Write a '0' to bits 1 to 4 of the REG\_AFE032\_CTRL register. A parameter for block 4 does not need to be calculated or written. Table 9 shows examples of this scenario.

f <sub>S</sub> (kSPS)	XCLK (MHz)	XCLK DIVIDER	REG_CLK_DIV (Hex)	DAC_CLK (MHz)	BLOCK 3	BLOCK 4
500	37.5	75	4E	0.5	Bypassed	Bypassed
800	19.2	24	27	0.8	Bypassed	Bypassed

#### Table 9. Example Cases of Bypassed Blocks 3 and 4

#### Block 3 Is Included, Block 4 Is Bypassed

If an external DSP transmits DAC samples to the device at a rate equal to one-fourth the DAC\_CLK frequency [that is,  $f_S = (DAC_CLK / 4)$ ], then block 3 is included and block 4 is bypassed. Write a '0' to bits 1, 2, and 4 and write a '1' to bit 3 of the REG\_AFE032\_CTRL register. A parameter for block 4 does not need to be calculated or written. Table 10 shows examples of this scenario.

		-				
f <sub>S</sub> (MSPS)	XCLK (MHz)	XCLK DIVIDER	REG_CLK_DIV (Hex)	DAC_CLK (MHz)	BLOCK 3	BLOCK 4
1.2	19.2	4	03	4.8	Included	Bypassed
0.625	37.5	15	0E	2.5	Included	Bypassed

#### Table 10. Example Cases of Block 3 Included and Block 4 Bypassed



## Block 3 Is Bypassed, Block 4 Is Included

If an external DSP transmits DAC samples to the device at a rate close to but less than the DAC\_CLK frequency (that is,  $f_S < DAC_CLK$ ), then block 3 is bypassed and block 4 is included. Write a '0' to bits 1, 2, and 3 and write a '1' to bit 4 of the REG\_AFE032\_CTRL register. In this case, the 32-bit parameter for block 4 must be calculated and written. This mode of operation is recommended as long as the ratio between  $f_S$  and DAC\_CLK is greater than 0.8 and less than 1 (that is, 0.8 DAC\_CLK <  $f_S < DAC_CLK$ ). Table 11 shows examples of this scenario.

To calculate the 32-bit parameter for block 4:

- Calculate the ratio between  $f_s$  and DAC\_CLK. Ratio =  $f_s / DAC_CLK$ .
- Multiply the ratio by 4,294,967,296. Product = (ratio)(4,294,967,296).
- The parameter for block 4 is equal to the integer part of the product found. Parameter = integer part of product.

The value of the 32-bit parameter for block 4 must be written in hexadecimal form to the REG\_OFFSET0, REG\_OFFSET1, REG\_OFFSET2, and REG\_OFFSET3 registers. The order should be such that the most significant byte of the parameter is stored in REG\_OFFSET0 and the least significant byte is stored in REG\_OFFSET3.

f <sub>S</sub> (MSPS)	XCLK (MHz)	XCLK DIVIDER	REG_CLK_ DIV (Hex)	DAC_CLK (MHz)	BLOCK 3	BLOCK 4	BLOCK 4 PARAMETER (Hex)
1.2	37.5	28	1D	1.339	Bypassed	Included	E5604189
0.8	37.5	45	48	0.833	Bypassed	Included	F5C28F5C

#### Table 11. Example Cases of Block 3 Bypassed and Block 4 Included

#### Block 3 and Block 4 Are Included

If an external DSP transmits DAC samples to the device at a rate close to but less than one-fourth the DAC\_CLK frequency [that is,  $f_S < (DAC_CLK / 4)$ ], then both block 3 and block 4 are included. Write a '0' to bits 1 and 2 and write a '1' to bits 3 and 4 of the REG\_AFE032\_CTRL register. In this case, the 32-bit parameter for block 4 must be calculated and written. This mode of operation is recommended as long as the ratio between  $f_S$  and DAC\_CLK is greater than 0.2 and less than 0.25 (that is, 0.2 DAC\_CLK <  $f_S < 0.25$  DAC\_CLK). Table 12 shows examples of this scenario.

To calculate the 32-bit parameter for block 4:

- Calculate the ratio between  $f_s$  and DAC\_CLK. Ratio =  $f_s / DAC_CLK$ .
- Multiply the ratio by 17,179,869,184. Product = (ratio)(17,179,869,184).
- The parameter for block 4 is equal to the integer part of the product found. Parameter = integer part of product.

The value of the 32-bit parameter for block 4 must be written in hexadecimal form to the REG\_OFFSET0, REG\_OFFSET1, REG\_OFFSET2, and REG\_OFFSET3 registers. The order should be such that the most significant byte of the parameter is stored in REG\_OFFSET0 and the least significant byte is stored in REG\_OFFSET3.

f <sub>S</sub> (MSPS)	XCLK (MHz)	XCLK DIVIDER	REG_CLK_ DIV (Hex)	DAC_CLK (MHz)	BLOCK 3	BLOCK 4	BLOCK 4 PARAMETER (Hex)
1	37.5	9	08	4.167	Included	Included	F5C28F5C
1	19.2	4	03	4.8	Included	Included	D5555555
0.4	22.5	14	0D	1.607	Included	Included	FEDCBA98

 Table 12. Example Cases of Block 3 and Block 4 Included



#### **DSP** Path State Retention

By default, blocks 1 through 4 of the DSP path retain their states in between DAC sample bursts (when DAC mode is deasserted). This default implementation functions best for most applications provided that all DAC sample bursts end with at least 24 samples of midrange values. These 24 samples provide a smooth transition to SPI mode. The default implementation can be altered by changing the DSP\_CFG bit of the REG\_AUX\_CTL register (see the *Register Map* section).

#### DAC Sample Clipping and Bias

The device provides the ability to clip DAC samples at the last stage of digital processing. An additional offset may be added to the clipped DAC sample at the user's discretion. The clipping circuit operates in the following manner:

- Program the device with an 11-bit clip value on the REG\_CLIP0 and REG\_CLIP1 registers.
- Program the device with an 11-bit clip offset value on the REG\_CLIP\_OFFSET0 and REG\_CLIP\_OFFSET1 registers.
- The programmed clip and offset values are not signed.
- The device digital logic compares the 11-bit magnitude of the DAC sample from the DSP path to the clip value.
- If the magnitude of the DAC sample is greater than the clip value, then the final DAC sample equals the clip value minus the offset value.
- If the magnitude of the DAC sample is less than the clip value, then the final DAC sample is unchanged.

#### AFE032 Reset Options

The device has two main types of reset mechanisms available. These reset options are hardware invoked and software invoked.

#### External Reset and Analog Shutdown Mode

The device can be disabled by asserting the external SD pin. Asserting the external SD pin causes the device digital logic to reset and also causes the analog module to shut down. Asserting the external SD pin disables the DAC clock and the entire device is disabled. Adhere to the following protocol when asserting the external SD pin:

- Assert the SD pin for at least 1 µs.
- Make sure that the device receives a valid XCLK clock before, during, and after the SD pin is asserted.

When the SD pin is deasserted, a valid XCLK signal must be sent to the device for at least 65,536 cycles. The device must be reprogrammed because all control registers are now reset.

#### Software Reset Options

Two types of software resets can be applied to the device digital logic: soft reset and sticky reset. Soft reset and sticky reset create a reset pulse that is eight DAC\_CLK cycles wide for the internal logic. These two reset commands are controlled by the REG\_AFE032\_CTL register. Sticky reset preserves all SPI register settings. In order to properly use the sticky reset, the values of all other control bits in the REG\_AFE032\_CTL register must be read and noted before asserting the sticky reset bit. Whatever is written to the REG\_AFE032\_CTL register is latched when performing a sticky reset. A soft reset, on the other hand, brings all device digital circuits to their default states.

After a soft reset or sticky reset is performed, a valid XCLK signal must be sent to the device for at least 65,536 cycles. The device must be reprogrammed because all control registers are now reset (with the exception of the REG\_AFE032\_CTL register bits in the case of a sticky reset).



### AFE032 Interrupts

The device contains three maskable interrupt signals: IFLAG\_INT, TFLAG\_INT, and DIG\_ERR\_INT. These interrupt masks are set by default and can be changed by writing to the REG\_FLAG\_CTL register. The interrupt masks are used to prevent any or all interrupt signals from commanding the active-low, open-drain interrupt pin (INT). The REG\_AFE\_STATUS register contains the status of the three maskable interrupt signals; these signals operate as follows:

- IFLAG\_INT: This interrupt is asserted when the PA goes to current limit mode for at least 16,384 DAC\_CLK cycles. If the PA goes to current limit mode but then falls out of current limit mode before 16,384 DAC\_CLK cycles have elapsed, then the IFLAG\_INT is not set.
- TFLAG\_INT: This interrupt is asserted when the PA goes to overtemperature mode.
- DIG\_ERR\_INT: This interrupt is a logical OR of all of individual interrupt vectors located in the REG\_DIG\_ERR register. See the Digital Interrupt Bits section and Table 26 for more details.

Note that reading the REG\_AFE\_STATUS register resets the IFLAG\_INT and TFLAG\_INT bits. Similarly, reading the REG\_DIG\_ERR register resets all of its bits. Note that the DIG\_ERR\_INT bit is not reset until the REG\_DIG\_ERR register is read.

#### Digital Interrupt Bits

The device can identify certain errors that may be caused because of improper programming or clocking. These errors are: AFIFO overflow, SPI write address fail, SPI illegal access, and SPI address error.

An AFIFO overflow error occurs if the ASYNCH FIFO used to convert DAC samples from the SPI to the DAC clock domain has overflowed. This error indicates that the external DSP is transmitting DAC samples at a rate ( $f_S$ ) higher than the maximum capability of the device DSP path for the current configuration. Refer to the *SPI Clock To DAC Clock Synchronization* section for details on the proper selection of  $f_S$  and XCLK.

An SPI write address fail error occurs when a read-only register is attempted to be written to. An SPI illegal access error occurs when a reserved SPI register is attempted to be written to.

An SPI address error occurs when an SPI register is attempted to be accessed incorrectly. This error is caused by several reasons: if a reserved SPI register is attempted to be written to, if an SPI register is attempted to be accessed with an incorrect address (that is, an address that does not exist in Table 13), or if a read-only register is attempted to be written to.

#### Initialization Sequence

The following initialization sequence must be performed (in addition to the sequence described in the *Power-Up Sequence* section) to ensure the device is ready for communication to the power line each time power is applied to the device and each time after a soft reset is performed:

- Ensure the shutdown pin is low.
- Ensure a valid XCLK signal is present.
- Configure the device in SPI mode by taking the DAC pin low.
- Wait for at least 65,536 XCLK cycles.
- Enable the PA\_NRF, TX\_RX\_NRF, and DAC\_NRF blocks.
- · Configure the two programmable clock dividers.
- Select the Tx filter band.
- Set the Enable assist bit (bit 7 in the REG\_HPF/LPF\_CFG register).
- Select which block in the digital path is used and which is bypassed.
- If block 4 is included, program the block 4 parameter of the DSP path.
- Set the Tx PGA, Rx PGA 1, and Rx PGA 2 gains.
- Enable the low-pass filter (LPF) and high-pass filter (HPF) according to the application requirements by writing to the REG\_DAC/HPF/LPF/PA\_CTL register. Make sure to enable the filter bias (bit 5 of the REG\_DAC/HPF/LPF/PA\_CTL register).
- Enable the DAC block by writing to register REG\_DAC/HPF/LPF/PA\_CTL (do not set the DAC pin high; just enable the DAC block to ensure the block is ready when the device is configured for transmission).
- Wait for two seconds to ensure all voltage references and signal path capacitors reach a steady state.



AFE032

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#### Power Amplifier Enable and Disable Sequences

Whether immediately after the initialization sequence or when transitioning from receiver mode to transmitter mode, one of the PA enable sequences described in this section must be used each time the device initiates a signal transmission on the power line via the power amplifier. The specific enable sequence used depends on whether the DAC block is enabled at least 300 µs prior to the start of the PA enable sequence or not.

#### PA Enable Sequence for a DAC Already Enabled Case

Use the following sequence if the DAC has been enabled for at least 300 µs.

- Simultaneously set the PA IQ current control bits (bits 6 and 7) and the PA current limit bits (bits 4 and 5) of the REG\_PA\_CURRENT\_CFG register. The PA IQ current control bits must be set to '10' (that is, the 95 mA option). The PA current limit bit settings depend on the application.
- Enable the Filter bias enable bit (bit 5) of the REG\_DAC/HPF/LPF/PA\_CTL register.
- Write '1' to the TX enable bit (bit 4), and '0' to the RX enable bit (bit 3) of the REG\_RX/TX\_CTL register.
- Wait for 50 µs.
- Write B4 (hex) to the REG\_DAC/HPF/LPF/PA\_CTRL register. (This setting enables the PA internal subregulation circuitry, maintains the LPF and filter bias, and keeps the DAC enabled while leaving the HPF and PA output stage disabled.)
- Wait for 20 µs.
- Write BC (hex) to the REG\_DAC/HPF/LPF/PA\_CTRL register. (This setting enables the PA output stage while keeping the PA internal sub-regulation circuitry, LPF, filter bias, and DAC enabled. The HPF remains disabled.)
- Enable the ENPAIQN bit (bit 3) and the ENPAIQP bit (bit 2) of the REG\_PA\_CURRENT\_CFG register.
- Enable the ENPCOMP bit (bit 7) and ENNCOMP bit (bit 6) of the REG\_RX/TX\_CTL register.
- Set the Tx PGA gain to the desired value.
- Wait for at least 20 DAC\_CLK cycles.
- Configure the device in DAC mode by taking the DAC pin high.
- Write the desired samples to the DAC following the procedure outlined in the DAC Mode section.

#### PA Enable Sequence Starting from a DAC in Disabled State Case

Use the following sequence if the DAC is disabled or if it is enabled for less than 300 µs prior to the start of the PA enable sequence:

- Simultaneously set the PA IQ current control bits (bits 6 and 7) and PA current limit bits (bits 4 and 5) of the REG\_PA\_CURRENT\_CFG register. The PA IQ current control bits must be set to '10' (that is, the 95 mA option). The PA current limit bit settings depend on the application.
- Enable the DAC by writing '1' to the DAC enable bit (bit 2) and the Filter bias enable bit (bit 5) of the REG\_DAC/HPF/LPF/PA\_CTL register.
- Write '1' to the TX enable bit (bit 4), and '0' to the RX enable bit (bit 3) of the REG\_RX/TX\_CTL register.
- Wait for 300 µs.
- Write B4 (hex) to the REG\_DAC/HPF/LPF/PA\_CTRL register. (This setting enables the PA internal subregulation circuitry, maintains the LPF and filter bias, and keeps the DAC enabled while leaving the HPF and PA output stage disabled.)
- Wait for 20 µs.
- Write BC (hex) to the REG\_DAC/HPF/LPF/PA\_CTRL register. (This setting enables the PA output stage while keeping the PA internal sub-regulation circuitry, LPF, filter bias, and DAC enabled. The HPF remains disabled.)
- Enable the ENPAIQN bit (bit 3) and the ENPAIQP bit (bit 2) of the REG\_PA\_CURRENT\_CFG register.
- Enable the ENPCOMP bit (bit 7) and ENNCOMP bit (bit 6) of the REG\_RX/TX\_CTL register.
- Set the Tx PGA gain to the desired value.
- Wait for at least 20 DAC\_CLK cycles.
- Configure the device in DAC mode by taking the DAC pin high.
- Write the desired samples to the DAC following the procedure outlined in the DAC Mode section.

## PA Disable Sequence

Use the following sequence to disable the PA:

- Disable the PA output enable bit (bit 3) on the REG\_DAC/HPF/LPF/PA\_CTRL register.
- Disable the PA internal sub-regulation circuitry (bit 4) of the REG\_DAC/HPF/LPF/PA\_CTL register.
- Disable the ENPAIQN bit (bit 3) and the ENPAIQP bit (bit 2) of the REG\_PA\_CURRENT\_CFG register.
- Disable the ENPCOMP bit (bit 7) and ENNCOMP bit (bit 6) of the REG\_RX/TX\_CTL register.
- Set the PA IQ current control bits (bits 6 and 7) of the REG\_PA\_CURRENT\_CFG register to '00' (that is, the 55 mA option).

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## **REGISTER MAP**

The AFE032 data registers are listed in the memory map of Table 13. A description of each register is given in the *Register Description* section.

				- Data Rogi		,				
REGISTER	ADDRESS (Hex)	DEFAULT VALUE (Hex)	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
REG_AFE032_CTL	00	00	Soft reset	Sticky reset	Reserved	Bypass Block 4	Bypass Block 3	Bypass Block 2	Bypass Block 1	DAC SPI select
REG_FLAG_CTL	01	E0	IFLAG mask	TFLAG mask	DIG_ERR mask			Reserved		
RESERVED	02	7F				Rese	erved			
REG_DAC/HPF/LPF/PA_CTL	03	00	LPF enable	HPF enable	Filter bias enable	PA enable	PA output enable	DAC enable	Reserved	Disable TLIM
REG_PA_CURRENT_CFG	04	00	PA IQ curi	ent control	PA cur	rent limit	ENPAIQN	ENPAIQP	ENPAICLN	ENPAICLP
REG_HPF/LPF_CFG	05	00	Enable Assist		LPF band select		Reserved	HPF ba	nd select	Reserved
REG_RX/TX_CTL	06	00	ENPCOMP	ENNCOMP	Reserved	Tx enable	Rx enable		TX_PGA gain	•
REG_RX_PGA_CFG	07	00		RX_PG	A1 gain		RX_PGA2 gain R			Reserved
REG_VREF/ZEROX	08	00	Zero-cross1 detect enable	Zero-cross2 detect enable	Zero-cross3 detect enable	PA_NRF enable	TX_RX_NRF DAC_NRF enable Reserved			erved
RESERVED	09	18				Rese	erved			
REG_AFE_STATUS	0A	01	IFLAG_INT	TFLAG_INT	Reserved	DIG_ERR_INT	Reserved			
RESERVED	0B	00	Reserved							
RESERVED	0C	00				Reserved				
REG_DIG_ERROR	0D	00	Reserved	Reserved	AFIFO overflow	SPI write address fail	SPI illegal SPI address Reserved			erved
REG_ID	0E	00	Die	_ID		Revision			Reserved	
REG_CLK_DIV	0F	03		DAC clock PC	DST_CLK_DIV			DAC clock P	RE_CLK_DIV	
REG_OFFSET_0	10	F5			M	ost significant byte	of block 4 parame	eter		
REG_OFFSET_1	11	C2				Second to MSB of	block 4 paramete	er		
REG_OFFSET_2	12	8F				Third to MSB of I	olock 4 parameter			
REG_OFFSET_3	13	5C			Le	ast significant byte	of block 4 param	eter		
REG_CLIP_0	14	FF				CLIP	_MSB			
REG_CLIP_1	15	E0		CLIP_LSB				Reserved		
REG_CLIP_OFFSET_0	16	00				CLIP_O	FF_MSB			
REG_CLIP_OFFSET_1	17	00		CLIP_OFF_LSB				Reserved		
REG_AUX_CTL	18	26	Reserved	Reserved	DSP_CFG			Reserved		
RESERVED	19 to 23	00				Rese	erved			
REG_COEFF1_BLOCK_2_MS	24	B9			В	its 11:4 of coefficie	ent 1 for filter block	k 2		
REG_COEFF1_BLOCK_2_LS	25	D0	B	its 3:0 of coefficie	nt 1 for filter block	x 2		Res	erved	
REG_COEFF2_BLOCK_2_MS	26	E8			В	its 11:4 of coefficie	ent 2 for filter block	k 2		
REG_COEFF2_BLOCK_2_LS	27	60	B	its 3:0 of coefficie	nt 2 for filter block	< 2		Res	erved	
							•			

### Table 13. Data Register Memory Map

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## Table 13. Data Register Memory Map (continued)

REGISTER	ADDRESS (Hex)	DEFAULT VALUE (Hex)	BIT 7	BIT 6 BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0
REG_COEFF3_BLOCK_2_MS	28	0F		В	its 11:4 of coefficie	ent 3 for filter block	2		- t
REG_COEFF3_BLOCK_2_LS	29	00		Bits 3:0 of coefficient 3 for filter block	2		Reser	ved	
REG_COEFF4_BLOCK_2_MS	2A	1D		В	its 11:4 of coefficie	ent 4 for filter block	2		
REG_COEFF4_BLOCK_2_LS	2B	CO		Bits 3:0 of coefficient 4 for filter block 2 Reserve				ved	
REG_COEFF5_BLOCK_2_MS	2C	0F		В	its 11:4 of coefficie	ent 5 for filter block	: 2		
REG_COEFF5_BLOCK_2_LS	2D	00		Bits 3:0 of coefficient 5 for filter block	2		Reser	ved	
REG_COEFF6_BLOCK_2_MS	2E	99		В	its 11:4 of coefficie	ent 6 for filter block	2		
REG_COEFF6_BLOCK_2_LS	2F	40		Bits 3:0 of coefficient 6 for filter block	2		Reser	ved	
REG_COEFF7_BLOCK_2_MS	30	CA		В	its 11:4 of coefficie	ent 7 for filter block	2		
REG_COEFF7_BLOCK_2_LS	31	10		Bits 3:0 of coefficient 7 for filter block	2		Reser	ved	
REG_COEFF8_BLOCK_2_MS	32	1F		В	its 11:4 of coefficie	ent 8 for filter block	: 2		
REG_COEFF8_BLOCK_2_LS	33	20		Bits 3:0 of coefficient 8 for filter block 2 Reserved					
REG_COEFF9_BLOCK_2_MS	34	3B		Bits 11:4 of coefficient 9 for filter block 2					
REG_COEFF9_BLOCK_2_LS	35	10	Bits 3:0 of coefficient 9 for filter block 2 Reserved						
REG_COEFF10_BLOCK_2_MS	36	1F	Bits 11:4 of coefficient 10 for filter block 2						
REG_COEFF10_BLOCK_2_LS	37	20	Bits 3:0 of coefficient 10 for filter block 2				Reser	ved	
REG_COEFF11_BLOCK_2_MS	38	23	Bits 11:4 of coefficient 11 for filter block 2						
REG_COEFF11_BLOCK_2_LS	39	B0	Bits 3:0 of coefficient 11 for filter block 2				Reser	ved	
REG_COEFF12_BLOCK_2_MS	ЗA	44		Bi	ts 11:4 of coefficie	ent 12 for filter bloc	k 2		
REG_COEFF12_BLOCK_2_LS	3B	20		Bits 3:0 of coefficient 12 for filter block	k 2		Reser	ved	
REG_COEFF1_BLOCK_1_MS	3C	B9		В	its 11:4 of coefficie	ent 1 for filter block	: 1		
REG_COEFF1_BLOCK_1_LS	3D	D0		Bits 3:0 of coefficient 1 for filter block	1		Reser	ved	
REG_COEFF2_BLOCK_1_MS	3E	E8		В	its 11:4 of coefficie	ent 2 for filter block	: 1		
REG_COEFF2_BLOCK_1_LS	3F	60		Bits 3:0 of coefficient 2 for filter block	1		Reser	ved	
REG_COEFF3_BLOCK_1_MS	40	0F		В	its 11:4 of coefficie	ent 3 for filter block	: 1		
REG_COEFF3_BLOCK_1_LS	41	00		Bits 3:0 of coefficient 3 for filter block	1		Reser	ved	
REG_COEFF4_BLOCK_1_MS	42	1D		В	its 11:4 of coefficie	ent 4 for filter block	: 1		
REG_COEFF4_BLOCK_1_LS	43	CO		Bits 3:0 of coefficient 4 for filter block	1		Reser	ved	
REG_COEFF5_BLOCK_1_MS	44	0F		В	its 11:4 of coefficie	ent 5 for filter block	: 1		
REG_COEFF5_BLOCK_1_LS	45	00		Bits 3:0 of coefficient 5 for filter block	1		Reser	ved	
REG_COEFF6_BLOCK_1_MS	46	23		В	its 11:4 of coefficie	ent 6 for filter block	.1		
REG_COEFF6_BLOCK_1_LS	47	B0		Bits 3:0 of coefficient 6 for filter block	. 1		Reser	ved	
REG_COEFF7_BLOCK_1_MS	48	44		В	its 11:4 of coefficie	ent 7 for filter block	.1		
REG_COEFF7_BLOCK_1_LS	49	20		Bits 3:0 of coefficient 7 for filter block	. 1		Reser	ved	
REG_DAC_SAMPLE_MS	4A	00		Bits 11:4	of DAC sample f	ed from DSP path	into DAC		
REG_DAC_SAMPLE_LS	4B	00	Bits 3:	0 of DAC sample fed from DSP path i	into DAC		Reser	ved	



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**AFE032** 

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## **Register Description**

7       6       5       4       3       2       1       0         Soft reset       Sticky reset       Reserved       Bypass Block 4       Bypass Block 3       Bypass Block 2       Bypass Block 1       DAC SPI         R0W       R0W       R       R/W       R/W <th></th>	
RO/W       RO/W       R       R/W       LEGEND: R/W       LEGEND: R/W = read and write; R0/W = read '0' and write (these bits always reset to '0' after being written); R = read-only.       R       R/W       R/W <th></th>	
LEGEND: RW = read and write; R0W = read '0' and write (these bits always reset to '0' after being written); R = read-only. Bit 7 Soft reset This bit creates a reset pulse to all AFE digital circuits and control registers. This bit is self resetting. 0 = Normal operation (default) 1 = Reset Bit 6 Sticky reset This bit resets all AFE digital circuits except the SPI registers. The SPI registers maintain all currently program values. This bit is self resetting. 0 = Normal operation (default) 1 = Reset Bit 5 Reserved This bit is reserved. Default = 0. Bit 4 Bypass Block 4 This bit determines if block 4 is included in the signal path. 0 = Include block 4 (default) 1 = Bypass block 3 This bit determines if block 3 is included in the signal path. 0 = Include block 3 (default) 1 = Bypass block 3 This bit determines if block 3 is included in the signal path. 0 = Include block 3 (default) 1 = Bypass block 3 This bit determines if block 3 is included in the signal path. 0 = Include block 3 (default) 1 = Bypass block 3 This bit determines if block 3 is included in the signal path. 0 = Include block 3 (default) 1 = Bypass block 3 This bit determines if block 3 is included in the signal path. 0 = Include block 3 (default) 1 = Bypass block 3	select
Bit 7       Soft reset         This bit creates a reset pulse to all AFE digital circuits and control registers. This bit is self resetting.         0 = Normal operation (default)         1 = Reset         Bit 6       Sticky reset         This bit resets all AFE digital circuits except the SPI registers. The SPI registers maintain all currently program values. This bit is self resetting.         0 = Normal operation (default)         1 = Reset         Bit 5       Reserved         This bit is reserved.         Default = 0.         Bit 4       Bypass Block 4         This bit determines if block 4 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         Bit 2       Bypass Block 2	
This bit creates a reset pulse to all AFE digital circuits and control registers. This bit is self resetting.         0 = Normal operation (default)         1 = Reset         Bit 6       Sticky reset         This bit resets all AFE digital circuits except the SPI registers. The SPI registers maintain all currently program values. This bit is self resetting.         0 = Normal operation (default)         1 = Reset         Bit 5       Reserved         This bit is reserved.         Default = 0.         Bit 4       Bypass Block 4         This bit determines if block 4 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass block 3         Bit 3       Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         Bit 2       Bypass Block 2	
This bit creates a reset pulse to all AFE digital circuits and control registers. This bit is self resetting.         0 = Normal operation (default)         1 = Reset         Bit 6       Sticky reset         This bit resets all AFE digital circuits except the SPI registers. The SPI registers maintain all currently program values. This bit is self resetting.         0 = Normal operation (default)         1 = Reset         Bit 5       Reserved         This bit is reserved.         Default = 0.         Bit 4       Bypass Block 4         This bit determines if block 4 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass Block 3         Bit 2       Bypass Block 2	
0 = Normal operation (default)         1 = Reset         Bit 6       Sticky reset         This bit resets all AFE digital circuits except the SPI registers. The SPI registers maintain all currently program values. This bit is self resetting.         0 = Normal operation (default)         1 = Reset         Bit 5       Reserved         This bit is reserved.         Default = 0.         Bit 4       Bypass Block 4         This bit determines if block 4 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         Bit 2       Bypass Block 2	
Bit 6       Sticky reset         This bit resets all AFE digital circuits except the SPI registers. The SPI registers maintain all currently program values. This bit is self resetting.         0 = Normal operation (default)         1 = Reset         Bit 5       Reserved         This bit is reserved.         Default = 0.         Bit 4       Bypass Block 4         This bit determines if block 4 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         Bit 2       Bypass Block 2	
This bit resets all AFE digital circuits except the SPI registers. The SPI registers maintain all currently program values. This bit is self resetting.         0 = Normal operation (default)         1 = Reset         Bit 5       Reserved         This bit is reserved.         Default = 0.         Bit 4       Bypass Block 4         This bit determines if block 4 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass Block 3         Bit 3       Bypass Block 3         Default = 0.	
0 = Normal operation (default) 1 = Reset         Bit 5       Reserved         This bit is reserved. Default = 0.         Bit 4       Bypass Block 4         This bit determines if block 4 is included in the signal path.         0 = Include block 4 (default) 1 = Bypass block 4         Bit 3       Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 4 (default) 1 = Bypass block 3         1 = Bypass Block 3         Bit 3       Bypass Block 3         0 = Include block 3 (default) 1 = Bypass block 3	med
1 = Reset         Bit 5       Reserved         This bit is reserved.         Default = 0.         Bit 4       Bypass Block 4         This bit determines if block 4 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass block 3         Bit 3       Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         Bit 2       Bypass Block 2	
Bit 4       Bypass Block 4         This bit is reserved.       This bit determines if block 4 is included in the signal path.         0 = Include block 4 (default)       1 = Bypass block 4         Bit 3       Bypass Block 3         This bit determines if block 3 is included in the signal path.       0 = Include block 3 (default)         1 = Bypass Block 3       This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)       1 = Bypass block 3         Bit 2       Bypass Block 2	
Default = 0.         Bit 4       Bypass Block 4         This bit determines if block 4 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass block 4         Bit 3       Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         Bit 2       Bypass Block 2	
This bit determines if block 4 is included in the signal path.         0 = Include block 4 (default)         1 = Bypass block 4         Bit 3       Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         Bit 2       Bypass Block 2	
Bit 3       0 = Include block 4 (default)         1 = Bypass block 4         Bit 3       Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         Bit 2       Bypass Block 2	
1 = Bypass block 4         Bit 3       Bypass Block 3         This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         Bit 2       Bypass Block 2	
This bit determines if block 3 is included in the signal path.         0 = Include block 3 (default)         1 = Bypass block 3         Bit 2       Bypass Block 2	
0 = Include block 3 (default)         1 = Bypass block 3         Bit 2       Bypass Block 2	
1 = Bypass block 3       Bit 2     Bypass Block 2	
This bit determines if block 2 is included in the signal path.	
0 = Include block 2 (default) 1 = Bypass block 2	
Bit 1 Bypass Block 1	
This bit determines if block 1 is included in the signal path.	
0 = Include block 1 (default) 1 = Bypass block 1	
Bit 0 DAC SPI select	
This bit sets the 12-bit DAC sample in either a 16-bit SCLK envelope or a 12-bit SCLK envelope.	
0 = 12-bit DAC burst (default) 1 = 16-bit DAC burst	

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TEXAS INSTRUMENTS

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7	6	5	4	3	2	1	0				
IFLAG mask	TFLAG mask	DIG_ERR mask			Reserved						
R/W	R/W	R/W			R						
_EGEND: R/W =	= read and write; F	R = read-only.									
Bit 7	IFLAG ma	isk									
	Software asserts this bit to prevent the current-limit interrupt from commanding the INT external pin. The current limit event still asserts the IFLAG_INT bit on the REG_AFE_STATUS register.										
	0 = Do no 1 = Mask	t mask IFLAG_INT (default)	)								
Bit 6	TFLAG m	TFLAG mask									
		Software asserts this bit to prevent the overtemperature interrupt from commanding the INT external pin. The overtemperature event still asserts the TFLAG_INT bit on the REG_AFE_STATUS register.									
	0 = Do not mask 1 = Mask TFLAG_INT (default)										
Bit 5	DIG_ERR mask										
	Software asserts this bit to prevent the digital error status bits from commanding the INT external pin. Any digital errors can still be read in the REG_DIG_ERROR register.										
	0 = Do no 1 = Mask	t mask digital errors (defaul	t)								
	Reserved										
Bits[4:0]	Reserved		These bits are reserved. Default = 0.								
Bits[4:0]	These bits	are reserved.									
Bits[4:0]	These bits	are reserved. ).	ESERVED R	egister (Addr	ess = 02h)						
<b>Bits[4:0]</b> 7	These bits	are reserved. ).	ESERVED R 4	egister (Addr 3	<b>ess = 02h)</b> 2	1	0				

LEGEND: R = read-only.

This register is reserved. Default = 7Fh



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	Table	17. REG_DAG	C/HPF/LPF/PA	_CTRL Regis	ter (Address	= 03h)	
7	6	5	4	3	2	1	0
LPF enable	HPF enable	Filter bias enable	PA enable	PA output enable	DAC enable	Reserved	Disable TLIM
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
LEGEND: R/W =	read and write.						
Bit 7	LPF enabl	le					
	This bit en	ables and disable	s the programmal	ble analog low-pas	ss filter (LPF).		
	0 = LPF di 1 = LPF er	sabled (default) nabled					
Bit 6	HPF enab	le					
	This bit en	ables and disable	s the programmal	ble analog high-pa	ass filter (HPF).		
	0 = HPF d 1 = HPF e	isabled (default) nabled					
Bit 5	Filter bias	enable					
		or power-down of			For normal Rx or ng the analog filter		
		ed (default)					
Bit 4	PA enable	9					
	This bit en	ables and disable	s the internal sub	-regulation circuitr	y of the power am	plifier.	
	0 = Disable 1 = PA ena	ed (default) abled					
Bit 3	PA output	t enable					
					tput stage functior PA output stage is		
		ed (default) tput enabled					
Bit 2	DAC enab	ble					
	This bit en	ables and disable	s the DAC.				
	0 = DAC d 1 = DAC e	lisabled (default) enabled					
Bit 1	Reserved						
	This bit is Default = 0						
Bit 0	Disable T	LIM					
	circuitry er		potential permane		. Warning: keeping device is strongly		
		IM enabled (defau IM disabled	ılt)				



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7	6	le 18. REG_PA_CURREN	3	2	1	0					
PA IQ curre	-	PA current limit	ENPAIQN	ENPAIQP	ENPAICLN	ENPAICLP					
R/		R/W	R/W	R/W	R/W	R/W					
EGEND: R/W =				10,00	10,00	10,00					
Bits[7:6]	PA IQ cur	PA IQ current control									
	These bits	control the PA programmable qui	escent current.								
	00 = > 55 01 = > 80 10 = > 95 11 = > 25	mA, typ									
Bits[5:4]	PA currer	PA current limit									
	These bits	These bits control the PA programmable current limit.									
	00 = > 1.2 01 = > 1.8 10 = > 2.5 11 = > 3.0	A, typ									
it 3	ENPAIQN	ENPAIQN									
	This bit er	This bit enables and disables the PA quiescent current negative bias circuitry.									
	0 = Disabl 1 = Enable	ed (default) ed									
Sit 2	ENPAIQP	ENPAIQP									
	This bit er	ables and disables the PA quiesco	ent current positive	bias circuitry.							
	0 = Disabl 1 = Enable	ed (default) ed									
Bit 1	ENPAICLN										
	This bit er	This bit enables and disables the PA negative current limit circuitry.									
	1 = The P.	A negative current limit circuitry is A negative current limit circuitry is vent occurs				ge if a current					
lit O	ENPAICL	P									
	This bit er	ables and disables the PA positive	e current limit circuit	ry.							
	1 = The P.	A positive current limit circuitry is e A positive current limit circuitry is o vent occurs				e if a current					



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		Table 19. REG_H	HPF/LPF_C	FG Register (A	ddress = 05h)	)				
7	6	5	4	3	2	1	0			
Enable assist		LPF band select		Reserved	HPF ban	d select	Reserved			
R/W		R/W		R/W	R/V	N	R			
LEGEND: R/W =	read and write;	R = read only.								
Bit 7	Enable a	ssist								
Dit i			art of the anal	og signal chain (Tx	and Rx PGAs and	filters) enabling	nocess			
	This bit must be asserted as part of the analog signal chain (Tx and Rx PGAs and filters) enabling process. 0 = Enable assist circuitry is not engaged (default)									
		1 = Enable assist circuitry is engaged (recommended for best performance)								
Bits[6:4]		LPF band select								
Dits[0.4]		This bit selects the programmable analog LPF cutoff frequency.								
		000 = 95  kHz (default)								
	000 = 95 001 = 150									
	010 = 42	0 kHz								
	011 = 49									
Bit 3	Reserve	Reserved								
	This bit is Default =	reserved. 0								
Bits[2:1]	HPF ban	HPF band select								
	This bit s	This bit selects the programmable analog HPF cutoff frequency.								
	00 = 35 k 01 = 150	Hz (default) kHz								
Bit 0	Reserve	d								
	This bit is Default =	reserved. 0								

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7	6	5	4	3	2	1	0
ENPCOMP	ENNCOMP	Reserved	TX enable	RX enable	-	TX_PGA gain	Ū
R/W	R/W	R/W	R/W	R/W		R/W	
EGEND: R/W =	read and write.						
Bit 7	ENPCOM	5					
	This bit en	ables the PA posi	itive start control.				
	0 = Disable 1 = Enable	ed (default) ed					
Bit 6	ENNCOM	2					
	This bit en	ables the PA neg	ative start control.				
	0 = Disable 1 = Enable						
Bit 5	Reserved						
	This bit is Default = 0						
Bit 4	TX enable	!					
	This bit en	ables and disable	s TX_PGA and c	onfigures the prograr	nmable filter	for either Tx or Rx mo	de.
	0 = Tx patł 1 = Tx patł	h disabled (defaul h enabled	t)				
Bit 3	RX enable	•					
	This bit en mode.	ables and disable	s RX_PGA1 and	RX_PGA2. This bit c	an either be	eft enabled or disable	d during Tx
	0 = Rx disa 1 = Rx ena	abled (default) abled					
Bits[2:0]	TX_PGA g	Jain					
	These bits	select the TX_PC	GA gain.				
	000 = 1.15 001 = 2.3 010 = 3.25 011 = 4.6						



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					Address = 07h)		
7	6	5	4	3	2	1	0
	RX_PG	A1 gain			RX_PGA2 gain		Reserved
	R	W			R/W		R/W
LEGEND: R/W =	read and write.						
Bits[7:4]	RX_PGA1	gain					
	These bits	select the RX_P	GA1 gain.				
	$\begin{array}{l} 0000 = 0.1\\ 0001 = 0.2\\ 0010 = 0.5\\ 0011 = 1\\ 0100 = 2\\ 0101 = 4\\ 0110 = 8\\ 0111 = 16\\ 1000 = 32 \end{array}$	5					
Bits[3:1]	RX_PGA2	gain					
	These bits	select the RX_P	GA2 gain.				
	000 = 1 (d 001 = 4 010 = 16	efault)					
Bit 0	Reserved						
	This bit is Default = (						

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	-	Table 22. REG	_VREF/ZERC	X Register (A	ddress = 08h)	1	
7	6	5	4	3	2	1	0
Zero-cross1 detect enable	Zero-cross2 detect enable	Zero-cross3 detect enable	PA_NRF enable	TX_RX_NRF enable	DAC_NRF enable	Rese	erved
R/W	R/W	R/W	R/W	R/W	R/W	F	R
EGEND: R/W =	read and write; F	R = read-only.					
it 7	Zero-cros	s1 detect enable					
	This bit er	ables and disable	s the zero-crossir	ng 1 detector.			
	0 = Disabl 1 = Enable	ed (default) ed					
it 6	Zero-cros	s2 detect enable					
	This bit er	ables and disable	s the zero-crossir	ng 2 detector.			
	0 = Disabl 1 = Enable	ed (default) ed					
it 5	Zero-cros	s3 detect enable					
	This bit er	ables and disable	s the zero-crossir	ng 3 detector.			
	0 = Disabl 1 = Enable	ed (default) ed					
it 4	PA_NRF e	enable					
	operation,	hables and disable this bit is enabled e cannot transmit	. This bit is disab	ed during operation	and internal reference nal conditions requ	ence bias genera uiring maximum p	tor. For norma ower savings
	0 = Disabl 1 = Enable	ed (default) ed					
it 3	TX_RX_N	RF enable					
	bit is enab		abled during oper	ational conditions	eference bias gene requiring maximum		
	0 = Disabl 1 = Enable	ed (default) ed					
it 2	DAC_NRF	enable					
	enabled. 7		during operationa		ice bias generator. ing maximum pow		
	0 = Disabl 1 = Enable	ed (default) ed					
6its[1:0]	Reserved						
	These bits Default = (	are reserved.					
		Table 23. I	RESERVED R	egister (Addr	ess = 09h)		
7	6	5	4	3	2	1	0
			Res	erved			
				R			

This register is reserved. Default = 18h



		able 24. REG	_AFE_STATUS	Register (A	aaress = van	)				
7	6	5	4	3	2	1	0			
IFLAG_INT	TFLAG_INT	Reserved	DIG_ERR_INT		Rese	rved				
R0	R0	R0	R		R					
EGEND: R/W	= read and write; F	R = read-only; R0	= read '0' (these bits	reset to '0' after	being read).					
		-								
Bit 7										
		set when the PA e ter being read.	enters the current lin	nit state for at lea	ast 16,384 DAC_C	LK cycles. This i	nterrupt is			
	0 = PA cu 1 = PA cu	rrent limit not dete rrent limit detected	cted (default)							
Bit 6	TFLAG_INT									
	This bit is	This bit is set when the PA enters the thermal limit state. This interrupt is cleared after being read.								
		ermal limit not dete ermal limit detecte								
Bit 5	Reserved									
	This bit is Default =									
Bit 4	DIG_ERR	DIG_ERR_INT								
	This bit is interrupt.	set when a digital	error is detected. The	ne REG_DIG_EI	RROR register mu	st be read in ord	er to clear thi			
		errors not detected	ed (default)							
Bits[3:0]	Reserved									
		s are reserved. not applicable								
	т	able 25. RES	ERVED Registe	rs (Address	= 0Bh to 0Ch	)				
-	6	5	4	3	2	1	0			
7										

LEGEND: R = read-only.

These registers are reserved.

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		Table 26. REG	_DIG_ERRO	R Register (A	ddress = 0Dh)					
7	6	5	4	3	2	1	0			
Reserved	Reserved	AFIFO overflow	SPI write address fail	SPI illegal access	SPI address error	Reser	ved			
R0	R0	R0	R0	R0	R0	R				
	-	ad '0' (these bits res								
-		of digital logic er	ror detection l	oits. All bits ar	e reset to '0' wh	ien read.				
ts[7:6]	Reserved									
	Reserveo Default =									
t 5	AFIFO ov									
. •		DAC ASYNCH FIFO	overflow.							
		al operation (default								
	1 = Error		,							
t 4	SPI write	e address fail								
	An error i	indicates that a read	l-only register wa	s attempted to be	e written to.					
	0 = Norm 1 = Error	al operation (default detected	t)							
t 3	SPI illega	SPI illegal access								
	An error i	An error indicates that a register reserved for factory testing and trimming was attempted to be written to.								
	0 = Norm 1 = Error	al operation (default detected	t)							
t 2	SPI addr	ess error								
	An error i written to	indicates that either	a nonexistent reg	gister, a reserved	register, or a read-	only register was a	attempted to			
	written to	al operation (default		gister, a reserved	register, or a read-	only register was a	attempted to			
its 1:0	written to 0 = Norm	al operation (default detected		gister, a reserved	register, or a read-	only register was a	attempted to			
its 1:0	written to 0 = Norm 1 = Error <b>Reserve</b>	aal operation (default detected d s are reserved.		gister, a reserved	register, or a read-	only register was a	attempted to			
its 1:0	written to 0 = Norm 1 = Error <b>Reserve</b> These bit	aal operation (default detected <b>d</b> is are reserved. 0	t)	gister, a reserved	-	only register was a	attempted to			
ts 1:0 7	written to 0 = Norm 1 = Error <b>Reserve</b> These bit	aal operation (default detected <b>d</b> is are reserved. 0	t)		-	only register was a	attempted to			
7 Die	written to 0 = Norm 1 = Error <b>Reserver</b> These bit Default = 6 <u>8</u> _ID	aal operation (default detected d s are reserved. 0 <b>Table 27.</b>	t) REG_ID Reg 4 Revision	jister (Addre	ss = 0Eh)	1 Reserved	·			
7 Die	written to 0 = Norm 1 = Error <b>Reserver</b> These bit Default = 6 <u>6</u> R	aal operation (default detected d s are reserved. 0 <b>Table 27.</b>	<sup>t)</sup> REG_ID Reg 4	jister (Addre	ss = 0Eh)	1	·			
7 Die	written to 0 = Norm 1 = Error <b>Reserver</b> These bit Default = 6 <u>6</u> R	aal operation (default detected d s are reserved. 0 <b>Table 27.</b>	t) REG_ID Reg 4 Revision	jister (Addre	ss = 0Eh)	1 Reserved	·			
7 Die EGEND: R = re	written to 0 = Norm 1 = Error <b>Reserver</b> These bit Default = 6 2_ID R ad-only. <b>Die_ID</b>	aal operation (default detected d s are reserved. 0 <b>Table 27.</b> 5	t) REG_ID Reg 4 Revision R	jister (Addre	ss = 0Eh)	1 Reserved	·			
7 Die EGEND: R = re	written to 0 = Norm 1 = Error <b>Reserver</b> These bit Default = 6 2_ID R ad-only. <b>Die_ID</b>	aal operation (default detected d s are reserved. 0 <b>Table 27.</b> 5	t) REG_ID Reg 4 Revision R	jister (Addre	ss = 0Eh)	1 Reserved	·			
7 Die EGEND: R = re its[7:6]	written to 0 = Norm 1 = Error <b>Reserved</b> These bit Default = 6 2_ID R 2ad-only. <b>Die_ID</b> These bit	al operation (default detected d s are reserved. 0 <b>Table 27.</b> 5	t) REG_ID Reg 4 Revision R	jister (Addre	ss = 0Eh)	1 Reserved	·			
7 Die :GEND: R = re ts[7:6]	written to 0 = Norm 1 = Error <b>Reserver</b> These bit Default = 6 <u>a</u> _ID R ad-only. <b>Die_ID</b> These bit Default = <b>Revision</b>	aal operation (default detected d ss are reserved. 0 <b>Table 27.</b> 5 ss are the die identifi 0 ss are the revision in	REG_ID Reg 4 Revision R	jister (Addre	ss = 0Eh)	1 Reserved	·			
7 Die	written to 0 = Norm 1 = Error <b>Reserven</b> These bit Default = 6 3_ID R pad-only. <b>Die_ID</b> These bit Default = <b>Revision</b> These bit	al operation (default detected d is are reserved. 0 <b>Table 27.</b> 5 s are the die identifi 0 s are the revision in 0	REG_ID Reg 4 Revision R	jister (Addre	ss = 0Eh)	1 Reserved	·			



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		Table 28. R	EG_CLK_DIV	Register (Add	ress = 0Fh)		
7	6	5	4	3	2	1	0
	DAC clock PC	ST_CLK_DIV			DAC clock PR	E_CLK_DIV	
	R/	W			R/W	/	
LEGEND: R/W =	= read and write.						
Bits[7:4]	DAC clock	CPOST_CLK_D	V				
		AC clock divider of					
		ST_CLK_DEV +		ock divider. DAC_C	LK is related to XC	LK by: XCLK = (I	PRE_CLK_DIV
Bits[3:0]	DAC clock	RE_CLK_DIV					
	Internal DA	C clock divider o	offset.				
	These bits × (POST_0 Default = 3	CLK_DEV + 1) x	e of the first clock of DAC_CLK.	divider. DAC_CLK i	s related to XCLK	by: XCLK = (PRE	_CLK_DIV + 1
		Table 29, RF	EG OFFSET (	) Register (Ad	dress = 10h)		
7	6	5	4	3	2	1	0
• 	Ŭ			of block 4 parame		•	0
				/W			
Bits[7:0]	-	are the MSB of	lock 4 parameter the 32-bit paramet	er for block 4 of the	e DSP path.		
		Table 30. RI	EG_OFFSET_	I Register (Ad	dress = 11h)		
7	6	5	4	3	2	1	0
			Second to MSB of	f block 4 parameter	•		
			R	/W			
LEGEND: R/W =	= read and write.						
Bits[7:0]	Second to	MSB of block	l parameter				
	These bits Default = 0		e to the MSB of th	ne block 4 paramet	er.		
		Table 31. RE	EG OFFSET	2 Register (Ad	dress = 12h)		
7	6	5	4	3	2	1	0
			Third to MSB of	block 4 parameter			
			R	/W			
LEGEND: R/W =	= read and write.						
Bits[7:0]	Third to M	ISB of block 4 p	arameter				
		are third in line t		block 4 parameter.			

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	٦	Table 32. REC	G_OFFSET_	3 Register (A	ddress = 13h)		
7	6	5	4	3	2	1	0
		Leas	st significant byte	e of block 4 para	meter		
			R	z/W			
LEGEND: R/W =	read and write.						
Bits[7:0]	Least signif	ficant byte of blo	ock 4 paramete	r			
	These bits a Default = 50	re the LSB of the h	block 4 parame	eter.			
		Table 33. RI	EG_CLIP_0	Register (Ad	dress = 14h)		
7	6	5	4	3	2	1	0
			CLIF	P_MSB			
			R	2/W			
LEGEND: R/W =	read and write.						
Bits[7:0]	CLIP_MSB						
	These bits a	re the MSB of the	e 11-bit clip valu	e. Input samples	to the DAC are clip	ped by this value.	
	These bits c Default = FF	ontrol DAC_CLIP	P[10:3].				
		Table 34. RI	EG_CLIP_1	Register (Ad	dress = 15h)		
7	6	5	4	3	2	1	0
	CLIP_LSB				Reserved		
	R/W				R0		
LEGEND: R/W =	read and write; R0	= read '0' (these	bits reset to '0'	after being read).			
Bits[7:5]	CLIP_LSB						
				e. Input samples	to the DAC are clipp	ed by this value.	
	These bits c Default = 07	ontrol DAC_CLIP	2[2:0].				
Bits[4:0]	Reserved						
	These bits a Default = 0	re reserved.					
	Tab	le 35. REG (	CLIP OFFSE	T 0 Register	r (Address = 16	h)	
7	6	5	4	3	2	1	0
	<b>U</b>			OFF_MSB		•	<b>v</b>
				2/W			
LEGEND: R/W =	read and write.						
Bits[7:0]	CLIP_OFF_	MSB					
[]			e 11-bit clin offs	et value. Clipped	DAC samples have	this offset subtra	cted from the
	clipped value						

These bits control DAC\_CLIP\_OFF[10:3]. Default = 0



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	Tab	le 36. REG_	CLIP_OFFSET	_1 Register	(Address = 17	'n)	
7	6	5	4	3	2	1	0
	CLIP_OFF_LSB				Reserved		
	R/W				R		
_EGEND: R/W =	read and write; R =	read-only.					
Bits[7:5]	CLIP_OFF_I	_SB					
	These bits an clipped value		ne 11-bit clip offset	value. Clipped	DAC Samples have	this offset subtr	acted from the
	These bits co Default = 0	ontrol DAC_CL	IP_OFF[2:0].				
Bits[4:0]	Reserved						
	These bits an Default = 0	re reserved.					
	-	Table 37. RI	EG_AUX_CTL	Register (A	ddress = 18h)		
7	6	5	4	3	2	1	0
Reserved	Reserved	DSP_CFG		Re	served		Reserved
R/W	R/W	R/W		I	R/W		R
_EGEND: R/W =	read and write; R =	read-only.					
Bits[7:6]	Reserved						
Bustinel	Reserved						
2.10[110]	This bits are Default = 0	reserved.					
	This bits are	reserved.					
	This bits are Default = 0 <b>DSP_CFG</b>		he DSP blocks to b	e retained or to	be forced to their m	eset values duri	ng SPI mode.
	This bits are Default = 0 <b>DSP_CFG</b> This bit allow 0 = Hold the	is the state of the DS		n the device is	in SPI mode (defaul		ng SPI mode.
Bit 5	This bits are Default = 0 <b>DSP_CFG</b> This bit allow 0 = Hold the	is the state of the DS	SP path blocks whe	n the device is	in SPI mode (defaul		ng SPI mode.
Bit 5	This bits are Default = 0 <b>DSP_CFG</b> This bit allow 0 = Hold the 1 = Reset the	is the state of the DS state of the DS e state of the D	SP path blocks whe	n the device is	in SPI mode (defaul		ng SPI mode.
Bit 5 Bits[4:1]	This bits are Default = 0 <b>DSP_CFG</b> This bit allow 0 = Hold the 1 = Reset the <b>Reserved</b> These bits an	is the state of the DS state of the DS e state of the D	SP path blocks whe	n the device is	in SPI mode (defaul		ng SPI mode.
Bit 5 Bits[4:1] Bit 0	This bits are Default = 0 <b>DSP_CFG</b> This bit allow 0 = Hold the 1 = Reset the <b>Reserved</b> These bits an Default = 3h	is the state of the DS state of the DS e state of the D re reserved.	SP path blocks whe	n the device is	in SPI mode (defaul		ng SPI mode.
Bit 5 Bits[4:1]	This bits are Default = 0 <b>DSP_CFG</b> This bit allow 0 = Hold the 1 = Reset the <b>Reserved</b> These bits an Default = 3h <b>Reserved</b> This bit is res Default = 0	vs the state of the DS state of the DS e state of the D re reserved. served.	SP path blocks whe SP path when the	n the device is device is in DA(	in SPI mode (defaul	t)	ng SPI mode.
Bit 5 Bits[4:1]	This bits are Default = 0 <b>DSP_CFG</b> This bit allow 0 = Hold the 1 = Reset the <b>Reserved</b> These bits an Default = 3h <b>Reserved</b> This bit is res Default = 0	vs the state of the DS state of the DS e state of the D re reserved. served.	SP path blocks whe SP path when the SERVED Regist	n the device is device is in DAG t <b>ers (Addres</b> 3	in SPI mode (defaul C mode	t)	ng SPI mode.
Bit 5 Bits[4:1] Bit 0	This bits are Default = 0 DSP_CFG This bit allow 0 = Hold the 1 = Reset the Reserved These bits an Default = 3h Reserved This bit is res Default = 0	vs the state of the DS e state of the DS e state of the D re reserved. served. ble 38. RES	SP path blocks whe SP path when the SERVED Regist 4 Rese	n the device is device is in DAG ters (Addres 3 rved	in SPI mode (defaul C mode SS = 19h to 23h	t)	
Bit 5 Bits[4:1] Bit 0	This bits are Default = 0 DSP_CFG This bit allow 0 = Hold the 1 = Reset the Reserved These bits an Default = 3h Reserved This bit is res Default = 0 Ta 6	vs the state of the DS e state of the DS e state of the D re reserved. served. ble 38. RES	SP path blocks whe SP path when the SERVED Regist	n the device is device is in DAG ters (Addres 3 rved	in SPI mode (defaul C mode SS = 19h to 23h	t)	
Bit 5 Bits[4:1] Bit 0	This bits are Default = 0 DSP_CFG This bit allow 0 = Hold the 1 = Reset the Reserved These bits an Default = 3h Reserved This bit is res Default = 0 Ta 6	vs the state of the DS e state of the DS e state of the D re reserved. served. ble 38. RES	SP path blocks whe SP path when the SERVED Regist 4 Rese	n the device is device is in DAG ters (Addres 3 rved	in SPI mode (defaul C mode SS = 19h to 23h	t)	
Bit 5 Bits[4:1] Bit 0 7 LEGEND: R = re	This bits are Default = 0 DSP_CFG This bit allow 0 = Hold the 1 = Reset the Reserved These bits an Default = 3h Reserved This bit is res Default = 0 Ta 6	vs the state of the DS e state of the DS e state of the D re reserved. served. ble 38. RES	SP path blocks whe SP path when the SERVED Regist 4 Rese	n the device is device is in DAG ters (Addres 3 rved	in SPI mode (defaul C mode SS = 19h to 23h	t)	
Bit 5 Bits[4:1] Bit 0 7 LEGEND: R = re	This bits are Default = 0 DSP_CFG This bit allow 0 = Hold the 1 = Reset the Reserved These bits al Default = 3h Reserved This bit is res Default = 0 Ta 6	vs the state of the DS e state of the D re reserved. served. <b>ble 38. RES</b> 5	SP path blocks whe SP path when the SERVED Regist 4 Rese R	n the device is device is in DAG ters (Addres 3 rved	in SPI mode (defaul C mode ss = 19h to 23h 2	t) ) 1	
Bit 5 Bits[4:1] Bit 0 7 LEGEND: R = re	This bits are Default = 0 DSP_CFG This bit allow 0 = Hold the 1 = Reset the Reserved These bits an Default = 3h Reserved This bit is res Default = 0 Ta 6 ead-only. rs are reserved.	ys the state of the DS e state of the DS e state of the D re reserved. served. ble 38. RES 5 9. REG_CO	SP path blocks whe SP path when the SERVED Regist 4 Rese R EFF1_BLOCK	n the device is device is in DAG ters (Addres 3 rved _2_MS Regi	in SPI mode (defaul C mode ss = 19h to 23h 2 ster (Address :	t) 1 = 24h)	0
Bit 5 Bits[4:1] Bit 0 7 LEGEND: R = re	This bits are Default = 0 DSP_CFG This bit allow 0 = Hold the 1 = Reset the Reserved These bits al Default = 3h Reserved This bit is res Default = 0 Ta 6	ys the state of the DS e state of the DS e state of the D re reserved. served. ble 38. RES 5 9. REG_CO 5	SP path blocks whe SP path when the SERVED Regist 4 Rese R EFF1_BLOCK_ 4	n the device is device is in DAG ters (Addres 3 rved _2_MS Regi 3	in SPI mode (defaul C mode ss = 19h to 23h 2 ster (Address = 2	t) ) 1	
Bit 5 Bits[4:1] Bit 0 7 LEGEND: R = re These register	This bits are Default = 0 DSP_CFG This bit allow 0 = Hold the 1 = Reset the Reserved These bits an Default = 3h Reserved This bit is res Default = 0 Ta 6 ead-only. rs are reserved.	ys the state of the DS e state of the DS e state of the D re reserved. served. ble 38. RES 5 9. REG_CO 5	SP path blocks whe SP path when the SP path when the 4 Rese R EFF1_BLOCK 4 its 11:4 of coefficien	n the device is device is in DAG ters (Addres 3 rved _2_MS Regi 3 nt 1 for filter blo	in SPI mode (defaul C mode ss = 19h to 23h 2 ster (Address = 2	t) 1 = 24h)	0
Bit 5 Bits[4:1] Bit 0 7 LEGEND: R = re	This bits are Default = 0 DSP_CFG This bit allow 0 = Hold the 1 = Reset the Reserved These bits al Default = 3h Reserved This bit is res Default = 0 Ta 6 ead-only. rs are reserved. Table 3 6	ys the state of the DS e state of the DS e state of the D re reserved. served. ble 38. RES 5 9. REG_CO 5	SP path blocks whe SP path when the SERVED Regist 4 Rese R EFF1_BLOCK_ 4	n the device is device is in DAG ters (Addres 3 rved _2_MS Regi 3 nt 1 for filter blo	in SPI mode (defaul C mode ss = 19h to 23h 2 ster (Address = 2	t) 1 = 24h)	0
Bit 5 Bits[4:1] Bit 0 7 LEGEND: R = re 7 LEGEND: R/W =	This bits are Default = 0 DSP_CFG This bit allow 0 = Hold the 1 = Reset the Reserved These bits an Default = 3h Reserved This bit is res Default = 0 Ta 6 ead-only. rs are reserved. Table 3 6	ys the state of the DS e state of the DS e state of the D re reserved. <b>ble 38. RES</b> 5 <b>9. REG_CO</b> 5 Bi	SP path blocks whe SP path when the SERVED Regist 4 Rese R EFF1_BLOCK_ 4 its 11:4 of coefficien R/	n the device is device is in DAG ters (Addres 3 rved _2_MS Regi 3 nt 1 for filter blo	in SPI mode (defaul C mode ss = 19h to 23h 2 ster (Address = 2	t) 1 = 24h)	0
Bit 5 Bits[4:1] Bit 0 7 LEGEND: R = re These register	This bits are Default = 0 DSP_CFG This bit allow 0 = Hold the 1 = Reset the Reserved These bits an Default = 3h Reserved This bit is res Default = 0 Ta 6 ead-only. rs are reserved. Table 3 6 e read and write. Bits 11:4 of	ys the state of the DS e state of the DS e state of the D re reserved. ble 38. RES 5 9. REG_CO 5 Bi coefficient 1 f	SP path blocks whe SP path when the SP path when the 4 Rese R EFF1_BLOCK 4 its 11:4 of coefficien	ters (Addres 3 rved 3 nt 1 for filter blo	in SPI mode (defaul C mode ss = 19h to 23h 2 ster (Address = 2 ck 2	t) 1 = 24h)	0

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Table 40. REG\_COEFF1\_BLOCK\_2\_LS Register (Address = 25h) 7 6 5 4 3 2 0 Bits 3:0 of coefficient 1 for filter block 2 Reserved R/W R LEGEND: R/W = read and write; R = read-only. Bits [7:4] Bits 3:0 of coefficient 1 for filter block 2 These bits contain the four least significant bits of coefficient 1 for filter block 2. Default = Dh Bits [3:0] Reserved These bits are reserved. Default = not applicable Table 41. REG\_COEFF2\_BLOCK\_2\_MS Register (Address = 26h) 7 6 5 4 3 2 1 0 Bits 11:4 of coefficient 2 for filter block 2 R/W LEGEND: R/W = read and write. Bits [7:0] Bits 11:4 of coefficient 2 for filter block 2 These bits contain the eight most significant bits of coefficient 2 for filter block 2. Default = E8h Table 42. REG\_COEFF2\_BLOCK\_2\_LS Register (Address = 27h) 7 6 5 4 3 2 0 Reserved Bits 3:0 of coefficient 2 for filter block 2 R/W R LEGEND: R/W = read and write; R = read-only. Bits [7:4] Bits 3:0 of coefficient 2 for filter block 2 These bits contain the four least significant bits of coefficient 2 for filter block 2. Default = 6hBits [3:0] Reserved These bits are reserved. Default = not applicable Table 43. REG COEFF3 BLOCK 2 MS Register (Address = 28h) 5 7 6 4 3 2 1 0 Bits 11:4 of coefficient 3 for filter block 2 R/W LEGEND: R/W = read and write. Bits [7:0] Bits 11:4 of coefficient 3 for filter block 2 These bits contain the eight most significant bits of coefficient 3 for filter block 2. Default = 0Fh Table 44. REG\_COEFF3\_BLOCK\_2\_LS Register (Address = 29h) 7 5 6 4 3 2 0 Bits 3:0 of coefficient 3 for filter block 2 Reserved R/W R

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its [7:4]	Bits 3:0 of coefficient 3 for fi	Iter block 2				
113 [7.4]	These bits contain the four leas		its of coefficient 3 for fi	ter block 2		
	Default = $0h$	st significant bi				
its [3:0]	Reserved					
	These bits are reserved.					
	Default = not applicable					
	Table 45. REG_COEF	F4_BLOCK	(_2_MS Register	(Address = 2	2Ah)	
7	6 5	4	3	2	1	0
	Bits	11:4 of coeffici	ent 4 for filter block 2			
		R	R/W			
EGEND: R/W =	read and write.					
its [7:0]	Bits 11:4 of coefficient 4 for t	filter block 2				
10 [110]	These bits contain the eight mo		hits of coefficient 4 for t	ilter block 2		
	Default = 1Dh	Jot olgrinourit		inter block 2.		
	Table 46. REG_COEF	F4_BLOCH	<_2_LS Register	Address = 2	Bh)	
7	6 5	4	3	2	1	0
Bit	ts 3:0 of coefficient 4 for filter block 2			Reserve	ed	
	R/W			R		
EGEND: R/W =	read and write; R = read-only.					
its [7:4]	Bits 3:0 of coefficient 4 for fi	Iter block 2				
	These bits contain the four least	st significant b	its of coefficient 4 for fil	ter block 2.		
	Default = Ch	0				
its [3:0]	Reserved					
	These bits are reserved.					
	Default = not applicable					
	Table 47. REG_COEF	F5 BLOCK	( 2 MS Register	(Address = 2	(Ch)	
7	6 5	4	3	2	1	0
	Bits	11:4 of coeffici	ent 5 for filter block 2			
		R	R/W			
EGEND: R/W =	read and write.					
	Bits 11:4 of coefficient 5 for t	filter block 2				
its [7:0]	Bits 11:4 of coefficient 5 for f		hits of coefficient 5 for	ilter block 2		
	These bits contain the eight mo		bits of coefficient 5 for	ilter block 2.		
	These bits contain the eight mo Default = 0Fh	ost significant l				
its [7:0]	These bits contain the eight mo Default = 0Fh <b>Table 48. REG_COEF</b>	ost significant b	<_2_LS Register	Address = 2		
i <b>ts [7:0]</b> 7	These bits contain the eight mo Default = 0Fh <b>Table 48. REG_COEF</b> 6 5	ost significant l		<b>Address = 2</b>	1	0
its [7:0] 7	These bits contain the eight mo Default = 0Fh <b>Table 48. REG_COEF</b>	ost significant b	<_2_LS Register	Address = 2	1	0

Bits [7:4]	Bits 3:0 of coefficient 5 for filter block 2
	These bits contain the four least significant bits of coefficient 5 for filter block 2.
	Default = 0h
Bits [3:0]	Reserved
	These bits are reserved. Default = not applicable

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	Table 49. RE	G COEFF6	BLOCK	2 MS Register	(Address = 2Eh)	
7	6 5		4	3	2 1	0
		Bits 11:4	of coefficient	t 6 for filter block 2		
			R/W	/		
EGEND: R/W =	read and write.					
Bits [7:0]	Bits 11:4 of coeffic	cient 6 for filte	r block 2			
	These bits contain t			s of coefficient 6 for	filter block 2.	
	Default = 99h					
			_BLOCK_	2_LS Register	(Address = 2Fh)	
7	6 5		4	3	2 1	0
В	its 3:0 of coefficient 6 for fill	ter block 2			Reserved	
	R/W				R	
EGEND: R/W =	read and write; R = read-o	nly.				
Bits [7:4]	Bits 3:0 of coeffici	ent 6 for filter	block 2			
5110 [7.4]	These bits contain t			of coefficient 6 for fi	Iter block 2	
	Default = 4h		grinicant bits			
Bits [3:0]	Reserved					
5115 [5.0]		n vo d				
	These bits are reserved Default = not application					
	T-11- 64 DE	0 005557			(4.1.1	
7				-	(Address = 30h)	0
7	6 5		4	3 t 7 for filter block 2	2 1	0
		Dits 11.4	R/W			
EGEND R/W =	read and write.		1.7.0			
	Bits 11:4 of coeffic	ient 7 for filte	r block 2			
Bits [7:0]						
Bits [7:0]		he eight most s	significant bits	s of coefficient 7 for	filter block 2.	
3its [7:0]	These bits contain t	he eight most s	significant bits	s of coefficient 7 for	filter block 2.	
3its [7:0]		he eight most s	significant bits	s of coefficient 7 for	filter block 2.	
3its [7:0]	These bits contain t Default = CAh	-	-		filter block 2. (Address = 31h)	
7	These bits contain t Default = CAh <b>Table 52. RE</b> 6 5	G_COEFF7	-		(Address = 31h) 2 1	0
7	These bits contain t Default = CAh <b>Table 52. RE</b> <u>6</u> 5 its 3:0 of coefficient 7 for fill	G_COEFF7	_BLOCK_	2_LS Register	(Address = 31h) 2 1 Reserved	0
7 B	These bits contain t Default = CAh <b>Table 52. RE</b> 6 5 its 3:0 of coefficient 7 for fill R/W	G_COEFF7	_BLOCK_	2_LS Register	(Address = 31h) 2 1	0
7 B	These bits contain t Default = CAh <b>Table 52. RE</b> <u>6</u> 5 its 3:0 of coefficient 7 for fill	G_COEFF7	_BLOCK_	2_LS Register	(Address = 31h) 2 1 Reserved	0
7 	These bits contain t Default = CAh <b>Table 52. RE</b> <u>6</u> 5 <u>its 3:0 of coefficient 7 for fill</u> R/W read and write; R = read-or	G_COEFF7	2_ <b>BLOCK</b> 4	2_LS Register	(Address = 31h) 2 1 Reserved	0
7 	These bits contain t Default = CAh <b>Table 52. RE</b> 6 5 its 3:0 of coefficient 7 for fill R/W e read and write; R = read-or <b>Bits 3:0 of coefficient</b>	G_COEFF7	BLOCK_4	2_LS Register 3	(Address = 31h) 2 1 Reserved R	0
7 	These bits contain t Default = CAh <b>Table 52. RE</b> 6 5 its 3:0 of coefficient 7 for fill R/W read and write; R = read-or <b>Bits 3:0 of coefficient</b> These bits contain t	G_COEFF7	BLOCK_4	2_LS Register 3	(Address = 31h) 2 1 Reserved R	0
7 B EGEND: R/W = Bits [7:4]	These bits contain t Default = CAh <b>Table 52. RE</b> <u>6</u> 5 <u>its 3:0 of coefficient 7 for fill</u> R/W read and write; R = read-or <b>Bits 3:0 of coefficien</b> These bits contain t Default = 1h	G_COEFF7	BLOCK_4	2_LS Register 3	(Address = 31h) 2 1 Reserved R	0
7 B EGEND: R/W = Bits [7:4]	These bits contain t Default = CAh <b>Table 52. RE</b> <u>6</u> 5 <u>its 3:0 of coefficient 7 for fill</u> R/W read and write; R = read-or <b>Bits 3:0 of coefficient</b> These bits contain t Default = 1h <b>Reserved</b>	G_COEFF7 ter block 2 only. ent 7 for filter he four least sig	BLOCK_4	2_LS Register 3	(Address = 31h) 2 1 Reserved R	0
7 BEGEND: R/W = Bits [7:4]	These bits contain t Default = CAh <b>Table 52. RE</b> <u>6</u> 5 <u>its 3:0 of coefficient 7 for fill</u> R/W read and write; R = read-or <b>Bits 3:0 of coefficien</b> These bits contain t Default = 1h	G_COEFF7 ter block 2 only. ent 7 for filter he four least sig	BLOCK_4	2_LS Register 3	(Address = 31h) 2 1 Reserved R	0
7 BEGEND: R/W = Bits [7:4]	These bits contain t Default = CAh <b>Table 52. RE</b> 6 5 its 3:0 of coefficient 7 for fill R/W read and write; R = read-or <b>Bits 3:0 of coefficient</b> These bits contain t Default = 1h <b>Reserved</b> These bits are reserved Default = not application	G_COEFF7 ter block 2 only. ent 7 for filter he four least sig rved. able	2_BLOCK_ 4 block 2 gnificant bits	2_LS Register 3	(Address = 31h) 2 1 Reserved R Iter block 2.	0
7 B	These bits contain t Default = CAh <b>Table 52. RE</b> 6 5 its 3:0 of coefficient 7 for fill R/W read and write; R = read-or <b>Bits 3:0 of coefficient</b> These bits contain t Default = 1h <b>Reserved</b> These bits are reserved Default = not application	G_COEFF7 beter block 2 bonly. ent 7 for filter the four least sig rved. able G_COEFF8	2_BLOCK_ 4 block 2 gnificant bits	2_LS Register 3	(Address = 31h) 2 1 Reserved R	0

LEGEND: R/W = read and write.



Bits [7:0]	Bits 11:4 of coefficier	nt 8 for filter block 2				
	These bits contain the	eight most significant b	its of coefficient 8 fe	or filter block 2.		
	Default = 1Fh					
	Table 54. REG	_COEFF8_BLOCK	_2_LS Registe	er (Address =	= 33h)	
7	6 5	4	3	2	1	0
Bit	s 3:0 of coefficient 8 for filter	block 2		Rese		
	R/W			F	R	
_EGEND: R/W = I	read and write; R = read-only					
Bits [7:4]	Bits 3:0 of coefficient	8 for filter block 2				
	These bits contain the	four least significant bit	s of coefficient 8 fo	r filter block 2.		
	Default = 2h					
Bits [3:0]	Reserved					
	These bits are reserved Default = not applicable					
	Table 55. REG_	COEFF9_BLOCK	_2_MS Registe	er (Address =	= 34h)	
7	6 5	4	3	2	1	0
		Bits 11:4 of coefficie	nt 9 for filter block	2		
		R/	W			
Bits [7:0]	Bits 11:4 of coefficier					
Bits [7:0]		nt 9 for filter block 2 eight most significant b	its of coefficient 9 f	or filter block 2.		
Bits [7:0]	These bits contain the Default = 3Bh				- 35h)	
7	These bits contain the Default = 3Bh <b>Table 56. REG</b> 6 5	eight most significant b _ <b>COEFF9_BLOCK</b> 4			<b>= 35h)</b> 1	0
7	These bits contain the Default = 3Bh <b>Table 56. REG</b> 6 5 s 3:0 of coefficient 9 for filter	eight most significant b _ <b>COEFF9_BLOCK</b> 4	_2_LS Registe	er (Address = 2 Rese	1 erved	0
7Bit	These bits contain the Default = 3Bh <b>Table 56. REG</b> 6 5 s 3:0 of coefficient 9 for filter R/W	eight most significant b _ <b>COEFF9_BLOCK</b> 4 block 2	_2_LS Registe	er (Address = 2	1 erved	0
7Bit	These bits contain the Default = 3Bh <b>Table 56. REG</b> 6 5 s 3:0 of coefficient 9 for filter	eight most significant b _ <b>COEFF9_BLOCK</b> 4 block 2	_2_LS Registe	er (Address = 2 Rese	1 erved	0
7 Bit LEGEND: R/W = I	These bits contain the Default = 3Bh <b>Table 56. REG</b> 6 5 s 3:0 of coefficient 9 for filter R/W	eight most significant b _COEFF9_BLOCK 4 block 2	_2_LS Registe	er (Address = 2 Rese	1 erved	0
7 Bit LEGEND: R/W = I	These bits contain the Default = 3Bh Table 56. REG 6 5 s 3:0 of coefficient 9 for filter R/W read and write; R = read-only Bits 3:0 of coefficient	eight most significant b _COEFF9_BLOCK 4 block 2	2_LS Registe 3	e <b>r (Address =</b> 2 Rese F	1 erved	0
7 Bit LEGEND: R/W = I	These bits contain the Default = 3Bh Table 56. REG 6 5 s 3:0 of coefficient 9 for filter R/W read and write; R = read-only Bits 3:0 of coefficient	eight most significant b _COEFF9_BLOCK 4 block 2 9 for filter block 2	2_LS Registe 3	e <b>r (Address =</b> 2 Rese F	1 erved	0
7 Bit LEGEND: R/W = 1 Bits [7:4]	These bits contain the Default = 3Bh Table 56. REG 6 5 s 3:0 of coefficient 9 for filter R/W read and write; R = read-only Bits 3:0 of coefficient These bits contain the	eight most significant b _COEFF9_BLOCK 4 block 2 9 for filter block 2	2_LS Registe 3	e <b>r (Address =</b> 2 Rese F	1 erved	0
7 Bit LEGEND: R/W = 1 <b>Bits [7:4]</b>	These bits contain the Default = 3Bh Table 56. REG 6 5 s 3:0 of coefficient 9 for filter R/W read and write; R = read-only Bits 3:0 of coefficient These bits contain the Default = 1h	eight most significant b <b>_COEFF9_BLOCK</b> 4 block 2 <b>: 9 for filter block 2</b> four least significant bit d.	2_LS Registe 3	e <b>r (Address =</b> 2 Rese F	1 erved	0
7 Bit LEGEND: R/W = 1 Bits [7:4]	These bits contain the Default = 3Bh Table 56. REG 6 5 s 3:0 of coefficient 9 for filter R/W read and write; R = read-only Bits 3:0 of coefficient These bits contain the Default = 1h Reserved These bits are reserve Default = not applicable	eight most significant b <b>_COEFF9_BLOCK</b> 4 block 2 <b>: 9 for filter block 2</b> four least significant bit d.	S_2_LS Registe 3	er (Address = 2 Rese F	1 erved R	0
7 Bit LEGEND: R/W = 1 <b>Bits [7:4]</b>	These bits contain the Default = 3Bh Table 56. REG 6 5 s 3:0 of coefficient 9 for filter R/W read and write; R = read-only Bits 3:0 of coefficient These bits contain the Default = 1h Reserved These bits are reserve Default = not applicable	eight most significant b _COEFF9_BLOCK _4 block 2	<pre>52_LS Registe 3 s of coefficient 9 fo (_2_MS Regist 3</pre>	er (Address = 2 Rese F r filter block 2.	1 erved R	0
7 Bit LEGEND: R/W = 1 Bits [7:4] Bits [3:0]	These bits contain the Default = 3Bh Table 56. REG 6 5 s 3:0 of coefficient 9 for filter R/W read and write; R = read-only Bits 3:0 of coefficient These bits contain the Default = 1h Reserved These bits are reserve Default = not applicable Table 57. REG_	eight most significant b _COEFF9_BLOCK _4 block 2	3 5 of coefficient 9 fo 6 of coefficient 9 fo 7 of coefficient 9 fo 8 of coefficient 9 fo 8 of coefficient 9 fo 9 of coefficient 9 fo 1 of coefficient 9 fo	er (Address = 2 Rese F r filter block 2.	1 erved R = <b>36h)</b>	
7 Bit: LEGEND: R/W = 1 Bits [7:4] Bits [3:0]	These bits contain the Default = 3Bh Table 56. REG_ 6 5 s 3:0 of coefficient 9 for filter R/W read and write; R = read-only Bits 3:0 of coefficient These bits contain the Default = 1h Reserved These bits are reserve Default = not applicable Table 57. REG_ 6 5	eight most significant b _COEFF9_BLOCK _4 block 2	3 5 of coefficient 9 fo 6 of coefficient 9 fo 7 of coefficient 9 fo 8 of coefficient 9 fo 8 of coefficient 9 fo 9 of coefficient 9 fo 1 of coefficient 9 fo	er (Address = 2 Rese F r filter block 2.	1 erved R = <b>36h)</b>	
7 Bit: LEGEND: R/W = 1 Bits [7:4] Bits [3:0]	These bits contain the Default = 3Bh Table 56. REG_ 6 5 s 3:0 of coefficient 9 for filter R/W read and write; R = read-only Bits 3:0 of coefficient These bits contain the Default = 1h Reserved These bits are reserve Default = not applicable Table 57. REG_ 6 5	eight most significant b _COEFF9_BLOCK _4 block 2	3 5 of coefficient 9 fo 6 of coefficient 9 fo 7 of coefficient 9 fo 8 of coefficient 9 fo 8 of coefficient 9 fo 9 of coefficient 9 fo 1 of coefficient 9 fo	er (Address = 2 Rese F r filter block 2.	1 erved R = <b>36h)</b>	
7 Bit LEGEND: R/W = 1 Bits [7:4] Bits [3:0] 7 LEGEND: R/W = 1	These bits contain the Default = 3Bh Table 56. REG_ 6 5 s 3:0 of coefficient 9 for filter R/W read and write; R = read-only Bits 3:0 of coefficient These bits contain the Default = 1h Reserved These bits are reserve Default = not applicable Table 57. REG_ 6 5	eight most significant b _COEFF9_BLOCK _4 block 2	3 5 of coefficient 9 fo 6 of coefficient 9 fo 7 of coefficient 9 fo 8 of coefficient 9 fo 8 of coefficient 9 fo 9 of coefficient 9 fo 1 of coefficient 9 fo	er (Address = 2 Rese F r filter block 2.	1 erved R = <b>36h)</b>	
7 Bit: LEGEND: R/W = 1 Bits [7:4] Bits [3:0] 7	These bits contain the Default = 3Bh Table 56. REG 6 5 s 3:0 of coefficient 9 for filter R/W read and write; R = read-only Bits 3:0 of coefficient These bits contain the Default = 1h Reserved These bits are reserve Default = not applicable Table 57. REG 6 5	eight most significant b _COEFF9_BLOCK _4 block 2	<b>3</b> s of coefficient 9 fo <b>C_2_MS Regist</b> <u>3</u> <u>nt 10 for filter block</u> W	er (Address = 2 Rese F r filter block 2.	1 erved R = <b>36h)</b>	

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7	6	5	4	3	2	1	0
Bi	ts 3:0 of coefficient ?	10 for filter block	2		Reser	ved	
	R/W				R		
EGEND: R/W =	= read and write; R =	read-only.					
its [7:4]	Bits 3:0 of c	oefficient 10 fo	r filter block 2				
, i i i i i i i i i i i i i i i i i i i				s of coefficient 10 fo	or filter block 2		
	Default = 2h		dot olgrinount on				
Bits [3:0]	Reserved						
	These bits a Default = not						
	Table 59	. REG_COE	FF11_BLOCH	_2_MS Regist	er (Address =	= 38h)	
7	6	5	4	3	2	1	0
		Bits	11:4 of coefficier	nt 11 for filter block	2		
			R/	W			
EGEND: R/W =	read and write.						
	<b>.</b>	<b>,,, ,</b> , , , , ,	<i></i>				
Bits [7:0]		coefficient 11 fo		to of on-fficient fit	for filter black C		
		•	nost significant b	ts of coefficient 11	for filter block 2.		
	Default = 23	11					
	Table 6	D. REG_COE	FF11_BLOC	(_2_LS Registe	er (Address =	= 39h)	
7	6	5	4	3	2	1	0
Bi	ts 3:0 of coefficient	11 for filter block	2		Reser	ved	
	R/W				R		
		read-only					
EGEND: R/W =	= read and write; R =	Teau-only.					
		·	r filtar black 2				
	Bits 3:0 of c	coefficient 11 for		s of coefficient 11 fr	or filter block 2		
	Bits 3:0 of c These bits c	coefficient 11 for		s of coefficient 11 fo	or filter block 2.		
Bits [7:4]	<b>Bits 3:0 of c</b> These bits c Default = Bh	coefficient 11 for		s of coefficient 11 fo	or filter block 2.		
Bits [7:4]	<b>Bits 3:0 of c</b> These bits co Default = Bh <b>Reserved</b>	coefficient 11 for		s of coefficient 11 fo	or filter block 2.		
Bits [7:4]	<b>Bits 3:0 of c</b> These bits c Default = Bh	coefficient 11 for contain the four le re reserved.		s of coefficient 11 fo	or filter block 2.		
Bits [7:4]	<b>Bits 3:0 of c</b> These bits co Default = Bh <b>Reserved</b> These bits a Default = not	coefficient 11 for ontain the four le re reserved. t applicable	ast significant bit			244	
Bits [7:4] Bits [3:0]	Bits 3:0 of o These bits co Default = Bh Reserved These bits a Default = not	coefficient 11 for ontain the four le re reserved. t applicable . REG_COEI	ast significant bit	_2_MS Registe	er (Address =	-	0
Bits [7:4]	<b>Bits 3:0 of c</b> These bits co Default = Bh <b>Reserved</b> These bits a Default = not	re reserved. t applicable . REG_COEI	ast significant bit FF12_BLOCK 4	2_ <b>MS Regist</b> o	er (Address = 2	<b>= 3Ah)</b> 1	0
Bits [7:4] Bits [3:0]	Bits 3:0 of o These bits co Default = Bh Reserved These bits a Default = not	re reserved. t applicable . REG_COEI	ast significant bit FF12_BLOCK 4 s 11:4 of coefficie	2_ <b>MS Regist</b> e 3 nt12 for filter block	er (Address = 2	-	0
Bits [7:4] Bits [3:0] 7	Bits 3:0 of c These bits c Default = Bh Reserved These bits a Default = not Table 61 6	re reserved. t applicable . REG_COEI	ast significant bit FF12_BLOCK 4	2_ <b>MS Regist</b> e 3 nt12 for filter block	er (Address = 2	-	0
Bits [7:4] Bits [3:0] 7	Bits 3:0 of o These bits co Default = Bh Reserved These bits a Default = not	re reserved. t applicable . REG_COEI	ast significant bit FF12_BLOCK 4 s 11:4 of coefficie	2_ <b>MS Regist</b> e 3 nt12 for filter block	er (Address = 2	-	0
Bits [7:4] Bits [3:0] 7 	Bits 3:0 of o These bits or Default = Bh Reserved These bits a Default = not Table 61 6	re reserved. t applicable . REG_COEI	ast significant bit FF12_BLOCK 4 : 11:4 of coefficie R/	2_ <b>MS Regist</b> e 3 nt12 for filter block	er (Address = 2	-	0
Bits [7:4] Bits [3:0] 7 EGEND: R/W =	Bits 3:0 of o These bits or Default = Bh Reserved These bits a Default = not Table 61 6 = read and write. Bits 11:4 of	coefficient 11 for ontain the four le re reserved. t applicable . REG_COEI 5 Bits	FF12_BLOCK 4 11:4 of coefficie R/ or filter block 2	2_ <b>MS Regist</b> e 3 <u>nt12 for filter block</u> W	<b>er (Address =</b> 2 2	-	0
Bits [7:4] Bits [3:0] 7	Bits 3:0 of o These bits or Default = Bh Reserved These bits a Default = not Table 61 6 = read and write. Bits 11:4 of	coefficient 11 for ontain the four le re reserved. t applicable . REG_COEI 5 Bits coefficient 12 for ontain the eight r	FF12_BLOCK 4 11:4 of coefficie R/ or filter block 2	2_ <b>MS Regist</b> e 3 nt12 for filter block	<b>er (Address =</b> 2 2	-	0
Bits [7:4] Bits [3:0] 7 .EGEND: R/W =	Bits 3:0 of c These bits c Default = Bh Reserved These bits a Default = not Table 61 6 = read and write. Bits 11:4 of These bits c Default = 44	coefficient 11 for ontain the four le re reserved. t applicable . REG_COEI 5 Bits coefficient 12 for ontain the eight r h	FF12_BLOCK 4 3 11:4 of coefficie R/ or filter block 2 nost significant b	2_ <b>MS Regist</b> 3 <u>ht12 for filter block :</u> W ts of coefficient 12	er (Address = 2 2 for filter block 2.	1	0
Bits [7:4] Bits [3:0] 7 .EGEND: R/W =	Bits 3:0 of c These bits c Default = Bh Reserved These bits a Default = not Table 61 6 = read and write. Bits 11:4 of These bits c Default = 44	coefficient 11 for ontain the four le re reserved. t applicable . REG_COEI 5 Bits coefficient 12 for ontain the eight r h	FF12_BLOCK 4 3 11:4 of coefficie R/ or filter block 2 nost significant b	2_ <b>MS Regist</b> e 3 <u>nt12 for filter block :</u> W	er (Address = 2 2 for filter block 2.	1	0
Bits [7:4] Bits [3:0] 7 EGEND: R/W = Bits [7:0]	Bits 3:0 of o These bits of Default = Bh Reserved These bits a Default = not Table 61 6 = read and write. Bits 11:4 of These bits of Default = 44 Table 62 6	coefficient 11 for ontain the four le re reserved. t applicable . REG_COEI 5 Bits coefficient 12 for ontain the eight r h 2. REG_COEI 5	FF12_BLOCK 4 5 11:4 of coefficie R/ or filter block 2 nost significant b FF12_BLOCK 4	2_ <b>MS Regist</b> 3 <u>ht12 for filter block :</u> W ts of coefficient 12	er (Address = 2 2 for filter block 2. er (Address = 2	1 : <b>3Bh)</b> 1	0
Bits [7:4] Bits [3:0] 7 LEGEND: R/W = Bits [7:0]	Bits 3:0 of o These bits of Default = Bh Reserved These bits a Default = not Table 61 6 = read and write. Bits 11:4 of These bits of Default = 44 Table 62	coefficient 11 for ontain the four le re reserved. t applicable . REG_COEI 5 Bits coefficient 12 for ontain the eight r h 2. REG_COEI 5 12 for filter block	FF12_BLOCK 4 5 11:4 of coefficie R/ or filter block 2 nost significant b FF12_BLOCK 4	The second state of the se	er (Address = 2 2 for filter block 2.	1 : <b>3Bh)</b> <u>1</u> ved	

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Bits [7:4]	Bits 3:0 of	coefficient 12 f	or filter block 2				
			least significant bits	s of coefficient 12	for filter block 2.		
	Default = 2h		5				
Bits [3:0]	Reserved						
		are reserved. ot applicable					
	Table 6	3. REG_CO	EFF1_BLOCK	_1_MS Regist	ter (Address =	: 3Ch)	
7	6	5	4	3	2	1	0
		Bi	its 11:4 of coefficie	nt 1 for filter block	x 1		
			R/	W			
LEGEND: R/W =	read and write.						
Bits [7:0]	Bits 11:4 o	f coefficient 1 f	or filter block 1				
	These bits of	contain the eight	t most significant bi	ts of coefficient 1	for filter block 1.		
	Default = B	9h					
	Table						
_			EFF1_BLOCK	_	-	-	
7	6	5	4	3	2	1	0
BI	ts 3:0 of coefficient		(1		Rese		
	R/V	-			R	L.	
LEGEND. R/W =	read and write; R	= read-only.					
Bits [7:4]	Bits 3.0 of	coefficient 1 fo	r filter block 1				
			least significant bits	s of coefficient 1 f	or filter block 1		
	Default = D		least significant bit				
Dito [2:0]	Reserved						
Bits [3:0]		are reserved.					
		ot applicable					
	Table 6	5. REG_CO	EFF2_BLOCK	_1_MS Regist	ter (Address =	: 3Eh)	
7	6	5	4	3	2	1	0
		Bi	its 11:4 of coefficie	nt 2 for filter block	< 1		
			R/	W			
LEGEND: R/W =	read and write.						
Bits [7:0]	Bits 11:4 o	f coefficient 2 f	or filter block 1				
	These bits of	contain the eight	t most significant bi	its of coefficient 2	for filter block 1.		
	Default = E	8h					
	<b>T</b> -616			4 10 Damier	ou (	2 <b>5</b> 6)	
_			EFF2_BLOCK	-	-	-	-
7	6	5	4	3	2	1	0
	ts 3:0 of coefficient			Ũ	Rese		Ŭ

R/W

LEGEND: R/W = read and write; R = read-only.

Bits [7:4]	Bits 3:0 of coefficient 2 for filter block 1
	These bits contain the four least significant bits of coefficient 2 for filter block 1.
	Default = 6h
Bits [3:0]	Reserved
	These bits are reserved. Default = not applicable

R

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	Table	67. REG_COEF	F3 BLOCK	1 MS Registe	er (Address	= 40h)	
7	6	5	4	3	2	<b>,</b> 1	0
		Bits	11:4 of coefficie	nt 3 for filter block	1		
			R/	W			
EGEND: R/W =	read and write.						
Bits [7:0]		of coefficient 3 for t		10 of coofficient 0 f	an filtan blaala d		
	Default = 0	contain the eight mo	JSt Significant bi	ts of coefficient 3 h	OF HILEF DIOCK T.		
	Delault = 0	FII					
	Table	68. REG_COEF	F3_BLOCK	_1_LS Registe	er (Address :	= 41h)	
7	6	5	4	3	2	1	0
E		t 3 for filter block 1				erved	
	R/				I	ર	
EGEND: R/W =	= read and write; R	= read-only.					
Bits [7:4]	Bite 2:0 of	coefficient 3 for fi	ltor block 1				
nta [7.4]		contain the four leas		s of coefficient 3 fo	r filter block 1		
	Default = 0		st significant bit				
Bits [3:0]	Reserved						
	These bits	are reserved.					
		ot applicable					
	Table	69. REG_COEF		1 MS Registe	ar (Addrass	– 42h)	
7	6	5	4	_1_iiie ittegiett	2	1	0
		Bits	11:4 of coefficie	nt 4 for filter block	1		
			R/	W			
EGEND: R/W =	read and write.						
Bits [7:0]		of coefficient 4 for					
		contain the eight mo	ost significant bi	ts of coefficient 4 f	or filter block 1.		
	Default = 1	Dh					
	Table	70. REG_COEF	F4_BLOCK	_1_LS Registe	er (Address :	= 43h)	
7	6	5	4	3	2	1	0
E	Bits 3:0 of coefficier	nt 4 for filter block 1			Rese	erved	
	R/	N			I	२	
EGEND: R/W =	= read and write; R	= read-only.					
		and the laws of the state	14 au 14 1 1 - 4				
		coefficient 4 for fi		a of an officient 4 fo	n filten blaals d		
				s of coefficient 4 to	r flitter block 1.		
	These bits	contain the four leas	st significant bit				
Bits [7:4]	These bits Default = C		st signincant bit				
Bits [7:4]	These bits Default = C <b>Reserved</b>	Ch	st significant bit				
Bits [7:4]	These bits Default = C <b>Reserved</b> These bits		st signincant bit				
Bits [7:4]	These bits Default = C <b>Reserved</b> These bits Default = n	Ch are reserved. ot applicable	-	1 MS Domint	or (Address	- 445)	
Bits [7:4] Bits [3:0]	These bits Default = C <b>Reserved</b> These bits Default = n	Ch are reserved.	-	_1_MS Registe	er (Address	= 44h)	0

R/W

LEGEND: R/W = read and write.



Bits [7:0] Bits 11:4 of coefficient 5 for filter block 1

These bits contain the eight most significant bits of coefficient 5 for filter block 1. Default = 0Fh

#### Table 72. REG\_COEFF5\_BLOCK\_1\_LS Register (Address = 45h)

7	6	5	4	3	2	1	0
Bi		nt 5 for filter block 1				erved	
	R/	W				R	
_EGEND: R/W =	read and write; R	= read-only.					
Bits [7:4]	Bits 3:0 of	coefficient 5 for filte	er block 1				
	These bits	contain the four least	significant bits	of coefficient for	filter block 1.		
	Default = 0	h					
Bits [3:0]	Reserved						
		are reserved.					
	Default = n	ot applicable					
	Table	73. REG_COEFF		1 MS Pogist	or (Addross	- 46b)	
7	6	5 5	4	3	2	- +011) 1	0
/	0	-		it 6 for filter block			0
		Dito TT	R/V				
_EGEND: R/W =	read and write		1.7, v	v			
	read and write.						
Bits [7:0]	Bits 11.4 c	of coefficient 6 for fill	ter block 1				
51(3 [7:0]		contain the eight mos		s of coefficient 6	for filter block 1		
	Default = 2	-	t significant bit		for mer block r.		
	Delault = 2	.511					
	Table	74. REG COEFF	6 BLOCK	1 LS Regist	er (Address	= 47h)	
7	Table 6	74. REG_COEFF	6_BLOCK_ 4	_1_LS Regist 3	er (Address	<b>= 47h)</b> 1	0
	6			_	2	-	0
	6	5 nt 6 for filter block 1		_	2 Res	1	0
Bi	6 its 3:0 of coefficier	5 nt 6 for filter block 1 W		_	2 Res	1 erved	0
Bi	6 its 3:0 of coefficier R/	5 nt 6 for filter block 1 W		_	2 Res	1 erved	0
Bi _EGEND: R/W =	6 its 3:0 of coefficier R/ read and write; R	5 nt 6 for filter block 1 W	4	_	2 Res	1 erved	0
Bi LEGEND: R/W =	6 its 3:0 of coefficier R/ read and write; R Bits 3:0 of	5 mt 6 for filter block 1 W = read-only. Coefficient 6 for filte	4	3	2 Res	1 erved	0
Bi LEGEND: R/W =	6 its 3:0 of coefficier R/ read and write; R Bits 3:0 of	5 <u>tt 6 for filter block 1</u> W = read-only. <b>Coefficient 6 for filte</b> contain the four least	4	3	2 Res	1 erved	0
Bi LEGEND: R/W = Bits [7:4]	6 its 3:0 of coefficier R/ read and write; R Bits 3:0 of These bits	5 <u>tt 6 for filter block 1</u> W = read-only. <b>Coefficient 6 for filte</b> contain the four least	4	3	2 Res	1 erved	0
Bi LEGEND: R/W = Bits [7:4]	6 its 3:0 of coefficien R/ read and write; R Bits 3:0 of These bits Default = E Reserved	5 <u>tt 6 for filter block 1</u> W = read-only. <b>Coefficient 6 for filte</b> contain the four least	4	3	2 Res	1 erved	0
Bi LEGEND: R/W = Bits [7:4]	6 its 3:0 of coefficien R/ read and write; R Bits 3:0 of These bits Default = E Reserved These bits	5 The for filter block 1 W = read-only. F coefficient 6 for filter contain the four least Bh	4	3	2 Res	1 erved	0
Bi LEGEND: R/W = Bits [7:4]	6 its 3:0 of coefficien R/ read and write; R Bits 3:0 of These bits Default = E Reserved These bits Default = n	5 at 6 for filter block 1 W = read-only. <b>coefficient 6 for filte</b> contain the four least Bh are reserved. tot applicable	4 er block 1 significant bits	3 of coefficient 6 f	2 Res	1 erved R	0
Bi LEGEND: R/W = Bits [7:4] Bits [3:0]	6 its 3:0 of coefficien R/ read and write; R Bits 3:0 of These bits Default = E Reserved These bits Default = n Table	5 th 6 for filter block 1 W = read-only. <b>coefficient 6 for filte</b> contain the four least Bh are reserved. tot applicable <b>75. REG_COEFF</b>	4 er block 1 significant bits	3 of coefficient 6 f	2 Res or filter block 1.	1 erved R	
Bi LEGEND: R/W = Bits [7:4]	6 its 3:0 of coefficien R/ read and write; R Bits 3:0 of These bits Default = E Reserved These bits Default = n	5 at 6 for filter block 1 W = read-only. <b>coefficient 6 for filte</b> contain the four least Bh are reserved. tot applicable <b>75. REG_COEFF</b> 5	4 er block 1 significant bits 7_BLOCK_ 4	3 of coefficient 6 f 1_ <b>MS Regis</b> 3	2 Res or filter block 1.	1 erved R	0
Bits [7:4] Bits [3:0]	6 its 3:0 of coefficien R/ read and write; R Bits 3:0 of These bits Default = E Reserved These bits Default = n Table	5 at 6 for filter block 1 W = read-only. <b>coefficient 6 for filte</b> contain the four least Bh are reserved. tot applicable <b>75. REG_COEFF</b> 5	4 er block 1 significant bits 7_BLOCK_ 4 :4 of coefficien	3 of coefficient 6 f 1_MS Regist 3 it 7 for filter block	2 Res or filter block 1.	1 erved R	
Bits [7:4] Bits [3:0] 7	6 its 3:0 of coefficien R/ read and write; R Bits 3:0 of These bits Default = E Reserved These bits Default = n Table 6	5 at 6 for filter block 1 W = read-only. <b>coefficient 6 for filte</b> contain the four least Bh are reserved. tot applicable <b>75. REG_COEFF</b> 5	4 er block 1 significant bits 7_BLOCK_ 4	3 of coefficient 6 f 1_MS Regist 3 it 7 for filter block	2 Res or filter block 1.	1 erved R	
Bits [7:4] Bits [3:0]	6 its 3:0 of coefficien R/ read and write; R Bits 3:0 of These bits Default = E Reserved These bits Default = n Table 6	5 at 6 for filter block 1 W = read-only. <b>coefficient 6 for filte</b> contain the four least Bh are reserved. tot applicable <b>75. REG_COEFF</b> 5	4 er block 1 significant bits 7_BLOCK_ 4 :4 of coefficien	3 of coefficient 6 f 1_MS Regist 3 it 7 for filter block	2 Res or filter block 1.	1 erved R	
Bits [7:4] Bits [3:0] 7 LEGEND: R/W =	6 its 3:0 of coefficient R/1 read and write; R Bits 3:0 of These bits Default = E Reserved These bits Default = n Table 6 read and write.	5 at 6 for filter block 1 W = read-only. <b>coefficient 6 for filte</b> contain the four least Bh are reserved. tot applicable <b>75. REG_COEFF</b> 5 Bits 11	4 er block 1 significant bits 7_BLOCK_ 4 :4 of coefficien R/V	3 of coefficient 6 f 1_MS Regist 3 it 7 for filter block	2 Res or filter block 1.	1 erved R	
Bits [7:4] Bits [3:0] 7 LEGEND: R/W =	6 its 3:0 of coefficien R/ read and write; R Bits 3:0 of These bits Default = E Reserved These bits Default = n Table 6 read and write. Bits 11:4 c	5 ht 6 for filter block 1 W = read-only. f coefficient 6 for filter contain the four least bh are reserved. tot applicable 75. REG_COEFF 5 Bits 11 bf coefficient 7 for filter	4 er block 1 significant bits 7_BLOCK_ 4 :4 of coefficien R/V ter block 1	3 of coefficient 6 f 1_ <b>MS Regis</b> t 3 it 7 for filter block	2 Res or filter block 1.	1 erved R	
Bi LEGEND: R/W = Bits [7:4] Bits [3:0]	6 its 3:0 of coefficien R/ read and write; R Bits 3:0 of These bits Default = E Reserved These bits Default = n Table 6 read and write. Bits 11:4 c	5 at 6 for filter block 1 W = read-only. F coefficient 6 for filter contain the four least Bh are reserved. tot applicable 75. REG_COEFF 5 Bits 11 bf coefficient 7 for filter contain the eight mos	4 er block 1 significant bits 7_BLOCK_ 4 :4 of coefficien R/V ter block 1	3 of coefficient 6 f 1_ <b>MS Regis</b> t 3 it 7 for filter block	2 Res or filter block 1.	1 erved R	

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Table 76. REG\_COEFF7\_BLOCK\_1\_LS Register (Address = 49h) 6 2 7 5 4 3 0 1 Bits 3:0 of coefficient 7 for filter block 1 Reserved R/W R LEGEND: R/W = read and write; R = read-only. Bits [7:4] Bits 3:0 of coefficient 7 for filter block 1 These bits contain the four least significant bits of coefficient 7 for filter block 1. Default = 2h Bits [3:0] Reserved These bits are reserved. Default = not applicable Table 77. REG\_DAC\_SAMPLE\_MS Register (Address = 4Ah) 7 6 5 4 3 2 1 0 Bits 11:4 of DAC sample fed from DSP path into DAC R/W LEGEND: R/W = read and write. Bits [7:0] Bits 11:4 of DAC sample fed from DSP path into DAC These bits contain the eight most significant bits of DAC sample fed from DSP path into DAC. Default = 00h Table 78. REG\_DAC\_SAMPLE\_LS Register (Address = 4Bh) 6 7 5 4 3 2 1 0 Bits 3:0 of DAC sample fed from DSP path into DAC Reserved R/W R LEGEND: R/W = read and write; R = read-only. Bits 3:0 of DAC sample fed from DSP path into DAC Bits [7:4] These bits contain the four least significant bits of DAC sample fed from DSP path into DAC. Default = 0h Bits [3:0] Reserved These bits are reserved.

Default = not applicable



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#### **POWER SUPPLIES**

The device has two low-voltage analog power-supply pins and one low-voltage digital supply pin. Internally, the two analog supply pins are connected to each other through back-to-back electrostatic discharge (ESD) protection diodes. These pins must be connected to each other on the application printed circuit board (PCB). Connecting the digital supply pin and the two analog supply pins together on the PCB is also recommended. Both low-voltage analog ground pins are also connected internally through back-to-back ESD protection diodes. These ground pins should also be connected to the digital ground pin on the PCB. Bypassing the low-voltage power supplies with a parallel combination of a  $10-\mu$ F and 100-nF capacitor is recommended. The PA block is biased separately from a high-voltage, high-current supply.

Three PA power-supply pins and three PA ground pins are available to provide a path for the high currents associated with driving the low impedance of the ac mains. Connecting the three PA supply pins together is recommended. Placing a 47- $\mu$ F to 100- $\mu$ F bypass capacitor in parallel with a 100-nF capacitor as close as possible to the device is also recommended. Care must be taken when routing the high-current ground lines on the PCB to avoid creating voltage drops in the PCB ground that may vary with changes in load current.

The device has many options to enable or disable the functional blocks to allow for flexible power-savings modes. Refer to the Electrical Characteristics: Power Supply table for power consumption in specific modes.

### DAC, SD, INT, TSENSE, TX\_FLAG, AND RX\_FLAG PINS

This section discusses the DAC, SD, INT, TSENSE, TX\_FLAG, and RX\_FLAG pins.

#### DAC (Pin 7)

The DAC pin is used to configure the SPI to either read data to or write data from the command and data registers, or to write data to the DAC register. Setting the DAC pin high allows access to the DAC register. Setting the DAC pin low allows access to the command and data registers.

#### SD (Pin 8)

The shutdown pin (SD) can be used to shut down the entire device for maximum power savings. When the SD pin is low, the device operates normally. When the SD pin is high, all circuit blocks within the device (including the serial interface) are placed in the lowest-power operating modes. In this condition, the entire device draws only 395  $\mu$ A (typical) of current. All register contents at the time the device is placed in shutdown mode are erased; when the device is re-enabled, the register contents are the device default values. Follow the protocol described in the External Reset and Analog Shutdown Mode section when asserting the SD pin.

#### INT (Pin 9)

The interrupt pin (INT) is an active-low, open-drain output pin that can be used to signal the microprocessor of an unusual operating condition that results from an anomaly on the power line. The INT pin can be triggered by external circuit conditions and SPI operations, depending upon the REG\_FLAG\_CTL register settings. The device can be programmed to issue an interrupt on current overload, thermal overload, and digital error conditions. Refer to the *AFE032 Interrupts* section for more information.

When an interrupt is signaled (that is, INT goes low), the contents of the IFLAG\_INT, TFLAG\_INT, and DIG\_ERR\_INT bits (bits 7, 6, and 4, respectively, in the REG\_AFE\_STATUS register) can be read to determine the type of interrupt that occurred. The REG\_FLAG\_CTL register settings should be configured each time the device is powered on.

Current overload and thermal overload conditions are explained in the *Current Overload* and *Thermal Overload* sections. Digital error conditions are explained in the *AFE032 Interrupts* section.

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## Current Overload

The maximum output current allowed from the power amplifier (PA) can be programmed with the external  $R_{SET}$  resistor connected between PA\_ISET (pin 26) and ground. The PA goes to current limit state if a fault condition occurs, causing the PA to source or sink more current than its programmed limit value. IFLAG\_INT (bit 7 in the REG\_AFE\_STATUS register) is set to '1' if the PA goes to current limit state for more than 16,384 DAC\_CLK cycles.

Setting the IFLAG mask bit of the REG\_FLAG\_CTL register prevents a fault condition from commanding the active-low, open-drain interrupt pin (INT). Note that the PA still goes to a current limit state to protect the device and the IFLAG\_INT bit is still set to '1'.

### CAUTION

ENPAICLN and ENPAICLP (bits 1 and 0 of the REG\_PA\_CURRENT\_CFG register, respectively) allow the current limit protection circuitry to be enabled or disabled. By default, the current limit protection circuitry is enabled and protects the device from damage during current overload events only if the ENPAICLN and ENPAICLP bits remain in their default states. Disabling these bits can potentially damage the device in an current overload event.

#### Thermal Overload

The device contains internal PA thermal shutdown protection circuitry that automatically disables the PA output stage if the junction temperature exceeds +165°C.

Note that the thermal shutdown protection circuitry only operates if a fault condition causes thermal overload (that is, forces the junction temperature to exceed +165°C) and the Disable TLIM bit (bit 0 in the REG\_DAC/HPF/LPF/PA\_CTL register) remains in the default state of '0'. The device thermal shutdown protection circuitry allows the PA to resume normal operation only when the junction temperature falls below +150°C. The TFLAG\_INT bit remains set to '1' even after the device returns to normal operation. The TFLAG\_INT bit can be reset to '0' by performing a read operation on the REG\_AFE\_STATUS register.

Setting the TFLAG mask bit of the REG\_FLAG\_CTL register prevents a thermal overload event from commanding the active-low, open-drain interrupt pin (INT). Note that the internal PA thermal shutdown protection circuitry still disables the PA output stage automatically (provided that a thermal overload condition occurs and the Disable TLIM bit is in set to '0') and the TFLAG\_INT bit is still set to '1'.



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#### TSENSE (Pin 35)

The TSENSE pin is internally connected to the anode of a temperature-sensing diode located within the PA output stage. Figure 26 shows a remote junction temperature sensor circuit that can be used to measure the device junction temperature. Measuring the device junction temperature is optional and is not required.

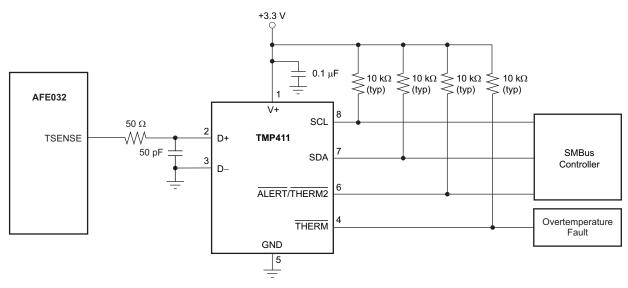


Figure 26. Interfacing the TMP411 to the AFE032

#### TX\_FLAG (Pin 47)

The TX\_FLAG pin is an open-drain output that indicates the readiness of the Tx signal path for transmission. When the TX\_FLAG pin is high, the transmit signal path is enabled and ready for transmission. When the TX\_FLAG pin is low, the transmit path is not ready for transmission.

#### RX\_FLAG (Pin 48)

The RX\_FLAG pin is an open-drain output that indicates the readiness of the Rx signal path for transmission. When the RX\_FLAG pin is high, the transmit signal path is enabled and ready for transmission. When the RX\_FLAG pin is low, the transmit path is not ready for transmission.

#### LINE-COUPLING CIRCUIT

The line-coupling circuit is one of the most critical circuits in a power-line modem. The line-coupling circuit has two primary functions: first, to block the low-frequency signal of the mains (commonly 50 Hz or 60 Hz) from damaging the low-voltage modem circuitry; second, to couple the modem signal to and from the ac mains. A typical line-coupling circuit is shown in Figure 27.

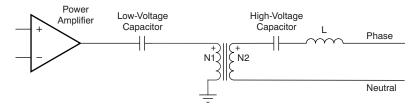


Figure 27. Simplified Line-Coupling Circuit



### **CIRCUIT PROTECTION**

Power-line communications are often located in operating environments that are harsh for electrical components connected to the ac line. Noise or surges from electrical anomalies (such as lightning, capacitor bank switching, inductive switching, or other grid fault conditions) can damage high-performance integrated circuits if proper protection is not provided. The AFE032, however, can survive even the harshest conditions by using a variety of techniques to protect the device.

Layout the protection circuitry in order to dissipate as much of the electrical disturbance as possible with a multilayer approach using metal-oxide varistors (MOVs), transient voltage suppression diodes (TVSs), Schottky diodes, and a Zener diode. These components dissipate the electrical disturbance before the anomaly reaches the device. Figure 28 shows the recommended strategy for transient overvoltage protection.

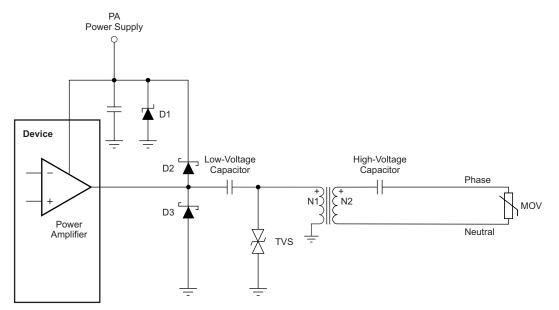


Figure 28. Transient Overvoltage Protection for AFE032

Note that the high-voltage coupling capacitor must be able to withstand pulses up to the clamping protection provided by the MOV. A metalized polypropylene capacitor, such as the 474MKP275KA from Illinois Capacitor<sup>™</sup>, is rated for 50 Hz to 60 Hz and 250 VAC to 310 VAC, and can withstand 24 impulses of 2.5 kV.



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#### Table 79 and Table 80 list several recommended transient protection components.

COMPONENT	DESCRIPTION	MANUFACTURER	MFR PART NO (OR EQUIVALENT)						
D1	Zener diode	Diodes, Inc.	1SMB59xxB <sup>(1)</sup>						
D2, D3	Schottky diode	Diodes, Inc.	B340A						
TVS	Transient voltage suppressor	Littelfuse, Inc.	SMCJxxCA <sup>(2)</sup>						
MOV	Varistor	Littelfuse, Inc.	TMOV20RP140E						
HV capacitor	High-voltage capacitor	Illinois Capacitor, Inc	474MKP275KA <sup>(3)</sup>						

#### Table 79. Recommended Transient Protection Devices (120 VAC, 60 Hz)

Select the zener breakdown voltage at the lowest available rating beyond the normal power-supply operating range. For example, 1SMB5931B is suitable for systems where PA\_VS = 15 V, whereas 1SMB5934B is suitable for systems where PA\_VS = 20 V.
 Select the TVS breakdown voltage at or slightly less than (0.5 x PA\_VS). For example, SMCJ6.0CA is suitable for systems where

 $PA_VS = 15 V$ , whereas SMCJ8.0CA is suitable for systems where  $PA_VS = 20 V$ .

(3) A common value for the high-voltage capacitor is 470 nF. Other values may be substituted depending on the application requirements. Note that when making a substitution, for reliability, the capacitor must be selected from the same family or an equivalent family of capacitors rated to withstand high-voltage surges on the power line.

#### Table 80. Recommended Transient Protection Devices (240 VAC, 50 Hz)

COMPONENT	DESCRIPTION	MFR PART NO (OR EQUIVALENT)			
D1	Zener diode	Diodes, Inc.	1SMB59xxB <sup>(1)</sup>		
D2, D3	Schottky diode	Diodes, Inc.	B340A		
TVS	Transient voltage suppressor	Littelfuse, Inc.	SMCJxxCA <sup>(2)</sup>		
MOV	Varistor	Littelfuse, Inc.	TMOV20RP300E		
HV capacitor	High-voltage capacitor	Illinois Capacitor, Inc	474MKP275KA <sup>(3)</sup>		

Select the zener breakdown voltage at the lowest available rating beyond the normal power-supply operating range. For example, 1SMB5931B is suitable for systems where PA\_VS = 15 V, whereas 1SMB5934B is suitable for systems where PA\_VS = 20 V.

(2) Select the TVS breakdown voltage at or slightly less than (0.5 × PA\_VS). For example, SMCJ6.0CA is suitable for systems where PA\_VS = 15 V, whereas SMCJ8.0CA is suitable for systems where PA\_VS = 20 V.

(3) A common value for the high-voltage capacitor is 470 nF. Other values may be substituted depending on the application requirements. Note that when making a substitution, for reliability, the capacitor must be selected from the same family or an equivalent family of capacitors rated to withstand high-voltage surges on the power line.

## THERMAL CONSIDERATIONS

In a typical power-line communications application, the device dissipates 2 W of power when transmitting to the low-impedance ac line. This amount of power dissipation can increase the junction temperature, which in turn can lead to a thermal overload that results in signal transmission interruptions if the PCB thermal design is not implemented properly. Proper management of heat flow from the device as well as good PCB design and construction are required to ensure proper device temperature, maximize performance, and extend device operating life.

The device is assembled in a 7-mm x 7-mm, QFN-48 package. As Figure 29 shows, this QFN package has a large-area exposed thermal pad on the underside that is used to conduct heat away from the device and to the underlying PCB.

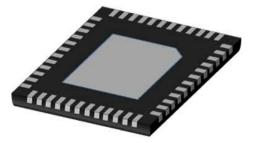


Figure 29. QFN Package with Large-Area Exposed Thermal Pad



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Some heat is conducted from the silicon die surface through the plastic packaging material and is transferred to the ambient environment. However, this route is not the primary thermal path for heat flow because plastic is a relatively poor conductor of heat. Heat also flows across the silicon die surface to the bond pads, through the wire bonds, to the package leads, and finally to the top layer of the PCB. While both of these paths for heat flow are important, the majority (nearly 80%) of the heat flows downward, through the silicon die, to the thermally-conductive die-attach epoxy, and to the exposed thermal pad on the underside of the package (as shown in Figure 30). Minimizing the thermal resistance of this downward path to the ambient environment maximizes the life and performance of the device.

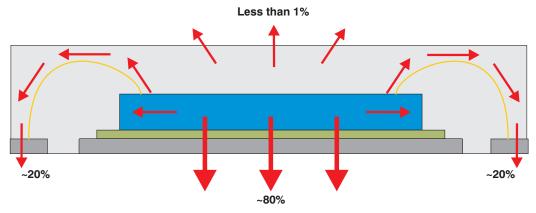


Figure 30. Heat Flow in the QFN Package

The exposed thermal pad must be soldered to the PCB thermal pad. The thermal pad on the PCB must be the same size as the exposed thermal pad on the underside of the QFN package. Refer to Application Report, *QFN/SON PCB Attachment* (SLUA271A), for recommendations on attaching the thermal pad to the PCB. Figure 31 illustrates the direction of heat spreading to the PCB from the device.

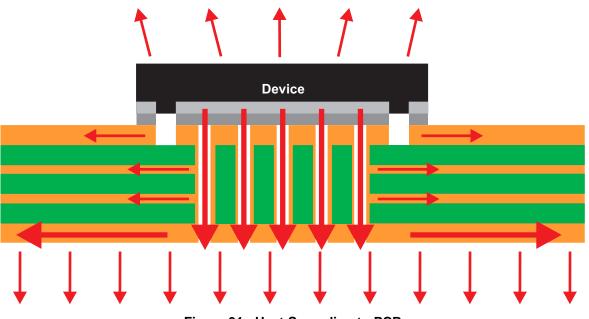
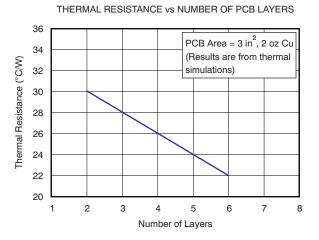


Figure 31. Heat Spreading to PCB

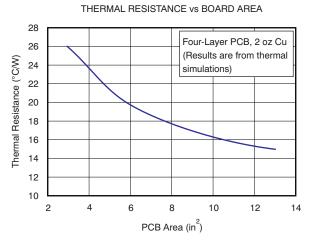
The heat spreading to the PCB is maximized if the thermal path is uninterrupted. Best results are achieved if the heat-spreading surfaces are filled with copper to the greatest extent possible, thus maximizing the percentage of area covered on each layer. As an example, a thermally robust, multilayer PCB design can consist of four layers with copper (Cu) coverage of 60% in the top layer, 85% and 90% in the inner layers (respectively), and 95% on the bottom layer.



Increasing the number of layers in the PCB, using thicker copper, and increasing the PCB area are all factors that improve the spread of heat. Figure 32 through Figure 34 show thermal resistance performance as a function of each of these factors.









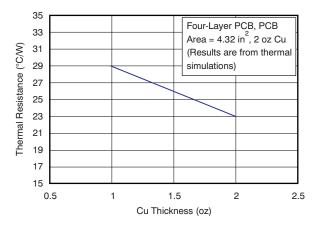


Figure 34. Thermal Resistance as a Function of Copper Thickness

For additional information on thermal PCB design using exposed thermal pad packages, refer to Application Reports *Analog Front-End Design for a Narrowband Power-Line Communications Modem Using the AFE031* (SBOA130) and *PowerPAD<sup>TM</sup> Thermally-Enhanced Package* (SLMA002E) (both available for download at www.ti.com).

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## **TYPICAL APPLICATION SCHEMATIC**

A schematic for a typical application is provided in Figure 35.

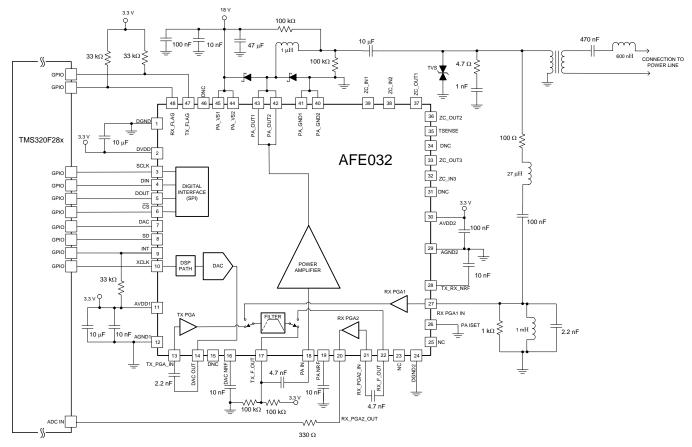


Figure 35. Typical Application with Transformer Coupling

## PACKAGING AND MECHANICALS

Complete mechanical drawings and packaging information are appended to the end of this data sheet.





## **REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Cł	nanges from Original (August 2013) to Revision A Page	е
•	Changed document from product preview to production data	1
•	Changed first sub-bullet of second Features bullet	1
•	Changed front page image	1
•	Added Ordering Information and Absolute Maximum Ratings table	
•	Added Thermal Information and Electrical Characteristics tables	3
•	Added SPI Timing Requirements table and Timing Diagrams section	0
•	Added Pin Configuration section	2
•	Added Functional Block Diagram section	4
•	Added Typical Characteristics section	5
•	Added Application Information section	7
•	Changed Series name in graph in Figure 23	
•	Changed Series names in graph legend in Figure 24	
•	Changed Series names in graph legend in Figure 25	



6-Feb-2020

## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
AFE032IRGZR	ACTIVE	VQFN	RGZ	48	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-3-260C-168 HR	-40 to 125	AFE032	Samples
AFE032IRGZT	ACTIVE	VQFN	RGZ	48	250	Green (RoHS & no Sb/Br)	NIPDAU	Level-3-260C-168 HR	-40 to 125	AFE032	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

6-Feb-2020

# PACKAGE MATERIALS INFORMATION

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Texas Instruments

## TAPE AND REEL INFORMATION





## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
AFE032IRGZR	VQFN	RGZ	48	2500	330.0	16.4	7.3	7.3	1.1	12.0	16.0	Q2
AFE032IRGZT	VQFN	RGZ	48	250	180.0	16.4	7.3	7.3	1.1	12.0	16.0	Q2

TEXAS INSTRUMENTS

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# PACKAGE MATERIALS INFORMATION

25-Mar-2015



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
AFE032IRGZR	VQFN	RGZ	48	2500	367.0	367.0	38.0
AFE032IRGZT	VQFN	RGZ	48	250	210.0	185.0	35.0

# **RGZ 48**

7 x 7, 0.5 mm pitch

# **GENERIC PACKAGE VIEW**

## VQFN - 1 mm max height

PLASTIC QUADFLAT PACK- NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

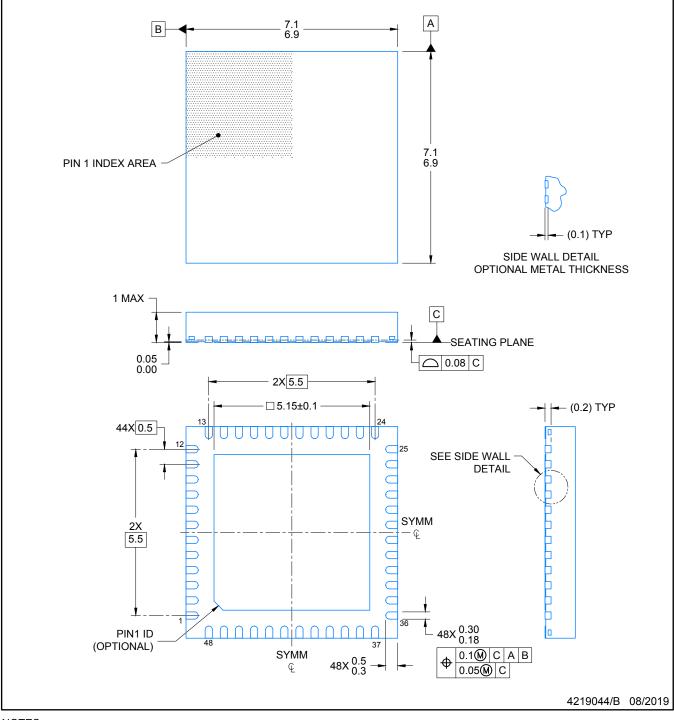


# <u>RGZ0048A</u>

# PACKAGE OUTLINE

## VQFN - 1 mm max height

PLASTIC QUADFLAT PACK- NO LEAD



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.

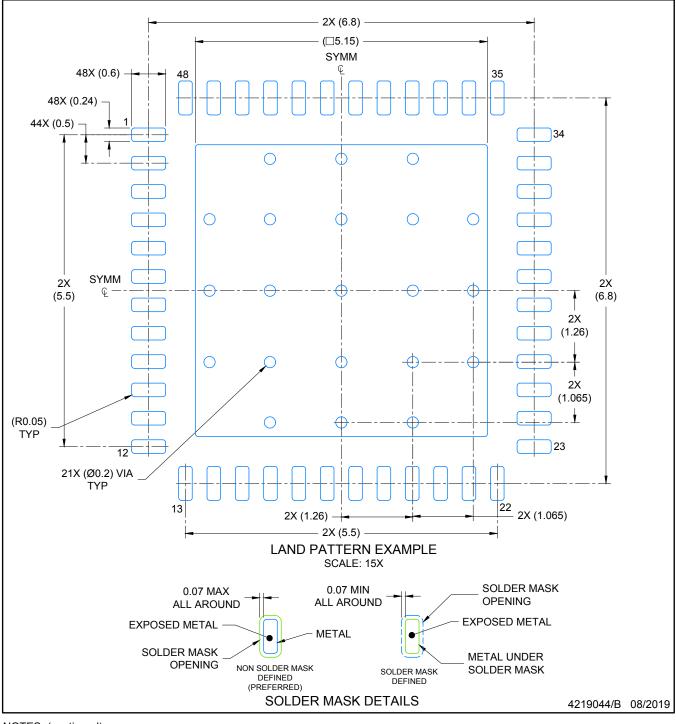


# **RGZ0048A**

# **EXAMPLE BOARD LAYOUT**

## VQFN - 1 mm max height

PLASTIC QUADFLAT PACK- NO LEAD



NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

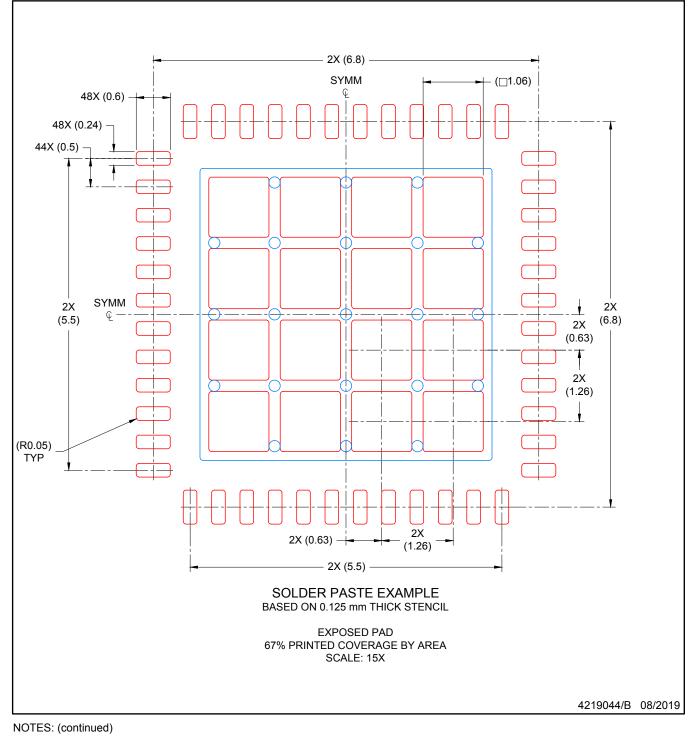


# **RGZ0048A**

## **EXAMPLE STENCIL DESIGN**

## VQFN - 1 mm max height

PLASTIC QUADFLAT PACK- NO LEAD



6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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